

STM32 connectivity expansion pack user guide

About this document

Version

1.4.0

Scope and purpose

The STM32 Connectivity Expansion Pack is an extension of the CMSIS-Pack standard established by Arm. The pack is compliant with the full CMSIS-Pack standard, with additional requirements/restrictions on the final pack to meet the STM standard. This pack uses libraries from the ModusToolbox™ environment. For more details, refer to <https://www.infineon.com/cms/en/design-support/tools/sdk/modustoolbox-software> You can select and configure the pack in the STM32CubeMX tool, make choices appropriate for your design, such as which CYW43xxx device to use, and then generate a project from your selection.

Document conventions

Convention	Explanation
Bold	Emphasizes heading levels, column headings, menus and sub-menus
<i>Italics</i>	Denotes file names and paths.
Courier New	Denotes APIs, functions, interrupt handlers, events, data types, error handlers, file/folder names, directories, command line inputs, code snippets
File > New	Indicates that a cascading sub-menu opens when you select a menu item

Abbreviations and definitions

The following define the abbreviations and terms used in this document:

- BSP – Board Support Package
- PAL – Platform Adaptation Layer
- WCM – Wi-Fi Connection Manager
- WHD – Wi-Fi Host Driver

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Expansion pack contents

1 Expansion pack contents

The following table shows the components and their versions included with the expansion pack:

Component name	Version	Details
abstraction-rtos	1.5.0	The RTOS abstraction layer provides simple RTOS services like threads, semaphores, mutexes, queues, and timers. It is not intended to be a full features RTOS interface, but they provide just enough support to allow for RTOS independent drivers and middleware.
btstack-integration	4.2.0	AIROC™ Bluetooth® host stack solution includes Bluetooth® stack library, Bluetooth® controller firmware and platform/OS porting layer. This component is compatible with ThreadX as well.
btstack	3.6.1	BTSTACK is Infineon's Bluetooth® Host Protocol Stack implementation. The stack is optimized to work with Infineon Bluetooth® controllers. The BTSTACK supports Bluetooth® BR/EDR and Bluetooth® LE core protocols.
command-console	4.0.0	This library provides a framework to add command console to your application and support Wi-Fi, iPerf, Bluetooth® Low Energy commands.
connectivity-utilities	4.0.0	The connectivity utilities library is a collection of general-purpose middleware utilities such as: JSON parser, Linked list, String utilities, Network helpers, Logging functions, and Middleware Error codes. Several connectivity middleware libraries will depend on this library.
core-lib	1.3.1	The Core Library provides basic types and utilities that can be used between different devices. This allows different libraries to share common items between themselves to avoid reimplementation and promote consistency.
device	1.4.0	Selects appropriate CYW43xxx firmware and drivers for selected connectivity device.
lwIP	2.1.2	lwIP is a small independent implementation of the TCP/IP protocol suite. The focus of the lwIP TCP/IP implementation is to reduce the RAM usage while still having a full-scale TCP. This making lwIP suitable for use in embedded systems with tens of kilobytes of free RAM and room for around 40 kilobytes of code ROM.
pal	1.4.0	Infineon-STM32 Platform Adaptation Layer (PAL).
wifi-host-driver	2.5.0	The Wi-Fi host driver (WHD) is an independent, embedded driver that provides a set of APIs to interact with Infineon WLAN chips. The WHD is an independent firmware product that is easily portable to any embedded software environment. Therefore, the WHD includes hooks for RTOS and TCP/IP network abstraction layers.
wcm	3.0.0	The Wi-Fi Connection Manager (WCM) is a library which helps application developers to manage Wi-Fi Connectivity. The library provides a set of APIs that can be used to establish and monitor Wi-Fi connections on Infineon platforms that support Wi-Fi connectivity.
whd-bsp-integration	2.1.0	The WHD library provides some convenience functions for connecting to a Board Support Package (BSP) that includes a WLAN chip. This library initializes the hardware and passes a reference to the communication interface on the board into WHD. It also sets up the LwIP based network buffers to be used for sending packets back and forth.
netxduo-network-interface-integration	1.0.0	This library is an integration layer that links the NetXDuo network stack with the underlying WHD. This library interacts with ThreadX, NetXDuo TCP/IP stack, and WHD. It contains the associated code to bind these components together.
lwip-network-interface-integration	1.0.0	This library is an integration layer that links the lwIP network stack with the underlying WHD and Ethernet driver. This library interacts with FreeRTOS, lwIP TCP/IP stack, WHD, and Ethernet driver. It contains the associated code to bind these components together.

Expansion pack contents

Component name	Version	Details
lwip-freertos-integration	1.0.0	This library contains the FreeRTOS dependencies needed by the Lightweight open-source TCP/IP stack, version: 2.1.2 to execute. See the https://savannah.nongnu.org/projects/lwip/ web site for details.
wifi-mfg-test	3.3.0	The WLAN Manufacturing Test Middleware application is used to validate the WLAN firmware and radio performance of the Wi-Fi device. The mfg-test middleware repo can accept the serial input byte stream from the Mfg Test application and transform the contained commands into IOVAR/IOCTL messages to the WLAN firmware. It can get the response from the WLAN firmware (if expected), and transport it back to the 'wl tool' running on the host.
secure-sockets	3.0.0	The secure sockets library provides APIs to create software that can send and/or receive data over the network using sockets. This library supports both secure and non-secure sockets, and abstracts the complexity involved in directly using network stack and security stack APIs. This library supports both IPv4 and IPv6 addressing modes for UDP and TCP sockets.
stm32_mw_freertos	10.4.6	The stm32_mw_freertos MCU component repository is common to all STM32Cube MCU embedded software packages, providing the FreeRTOS Middleware part.
wpa3-external-supplicant	1.1.0	The WPA3 External Supplicant supports WPA3 SAE authentication using HnP (Hunting and Pecking Method) using RFC https://datatracker.ietf.org/doc/html/rfc7664 and H2E (Hash to Element Method) using RFC https://datatracker.ietf.org/doc/html/draft-irtf-cfrg-hash-to-curve-10 and following 802.11 spec 2016.
LPA	4.0.0	The LPA middleware provides an easy way to make the low-power features available to developers in the form of a portable configuration layer. The LPA library functions are only used by Wi-Fi. LPA provides features for MCU Low Power, Wi-Fi Low Power and Bluetooth Low Power but the LPA library only needs to be included in applications that use Wi-Fi low power.

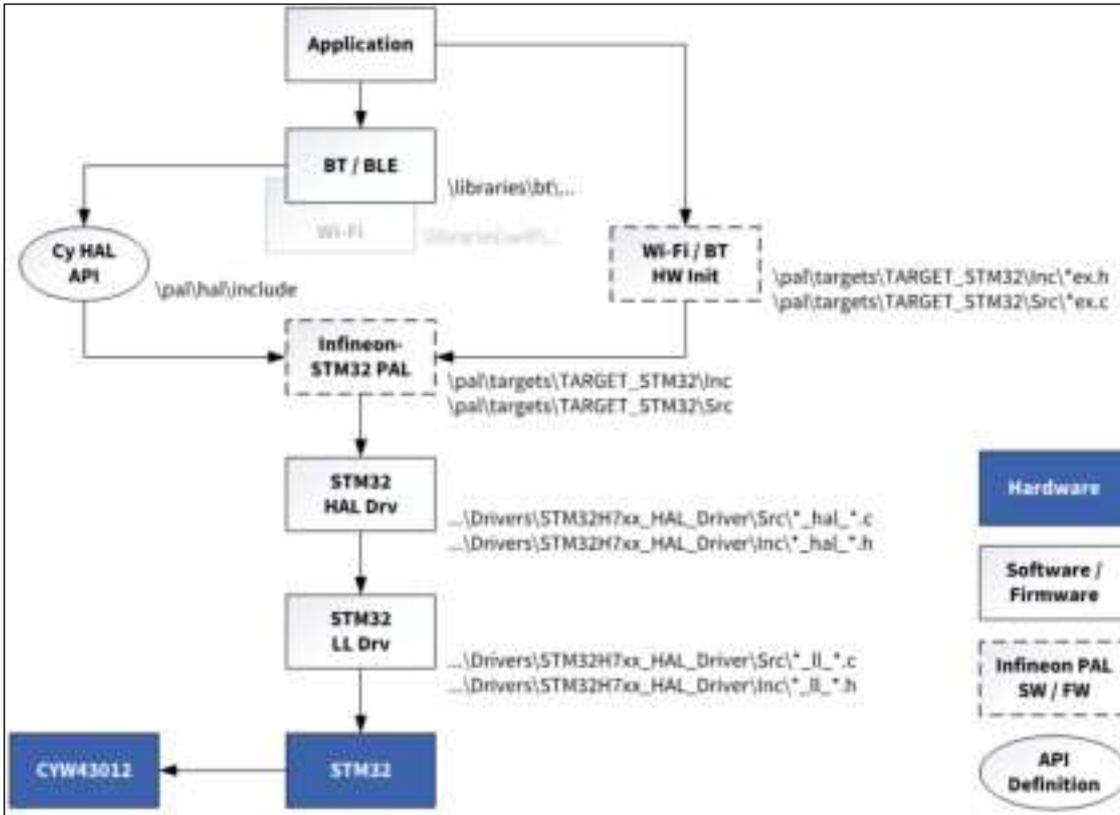
1.1 Infineon-STM32 Platform Adaptation Layer (PAL)

The Infineon-STM32 PAL is based on the STM32 Driver MCU Component HAL, and it offers the minimum set of (required) APIs for Infineon-STM32 PAL. The supported HAL versions are:

STM32Cube HAL package	STM32Cube MCU verified package version
STM32H7 Series	1.11.0
STM32L5 Series	1.5.0
STM32U5 Series	1.2.0
STM32H5 Series	1.0.0

Expansion pack contents

The PAL integrates the STM32 HAL APIs underneath the Infineon HAL APIs expected by the Infineon Connectivity Libraries. The following figure shows the architectural intent of the Infineon-STM32 PAL:



We created the Infineon-STM32-PAL to meet the following guidelines:

- Developers will continue to use STM32CubeMX and/or STM32 HAL APIs to configure STM32 MCU hardware.
- Developers will communicate to the PAL what STM32 hardware that they have selected and configured for communicating with a CYW43xxx via an initialization API.
- Infineon-STM32 PAL adapts only the minimum set of Infineon HAL APIs to STM32 HAL in order to communicate and control Infineon's CYW43xxx connectivity device(s).
- The Infineon PAL layer behaves like the Infineon HAL as much as possible to minimize impact to the Infineon libraries. The Infineon PAL adapts the following STM32 HAL Drivers:
 - GPIO
 - LPTimer
 - SDIO
 - SPI
 - TRNG
 - UART

1.2 Supported STM32 MCUs

- STM32H7xx
- STM32L5xx
- STM32U5xx
- STM32H5xx

Expansion pack contents

1.3 Supported STM32 boards

- STM32H747I-DISCO Discovery kit
- STM32L562E-DK
- STM32U575I-EV
- NUCLEO-H563ZI

1.4 Supported connectivity modules

Infineon's CYW43xxx Wi-Fi-Bluetooth® combo chip family:

- CYW43012
- CYW43439 / CYW43438 / CYW4343W
- CYW4373 / CYW4373/E

1.5 Compatible software

- STM32 CubeMX 6.8.0
- STM32 CubeIDE 1.12.0
- IAR EWARM 9.30.1

Download/install/import expansion pack

2 Download/install/import expansion pack

2.1 Downloading the pack

Download the expansion pack from GitHub:

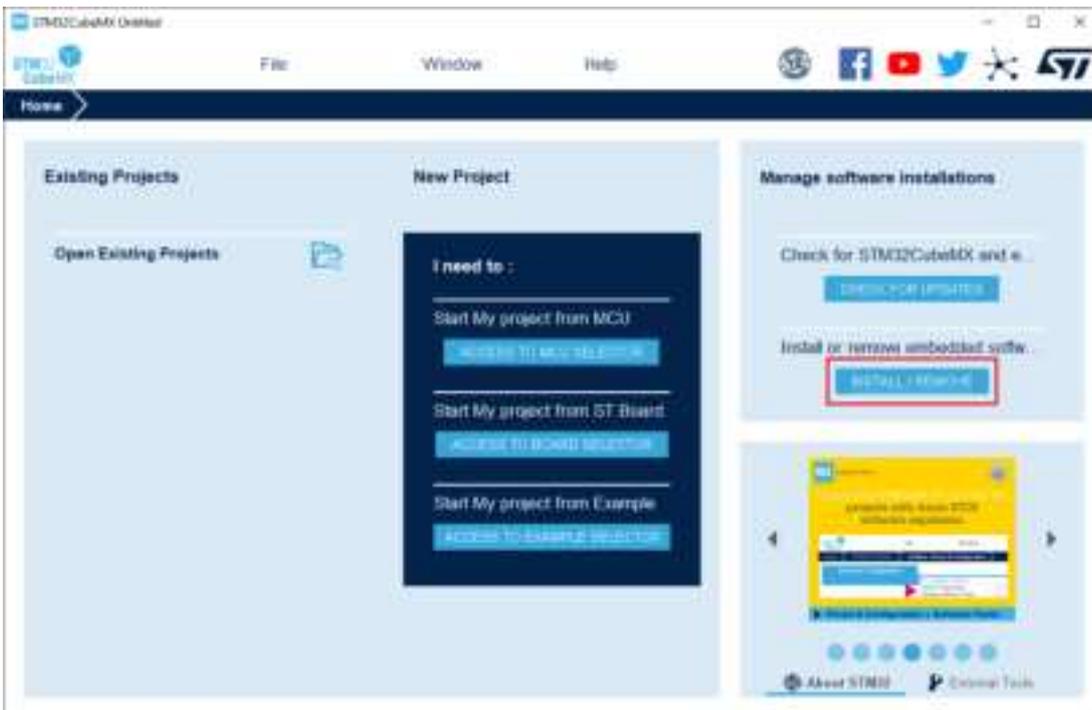
<https://github.com/Infineon/stm32-connectivity/releases/tag/release-v1.4.0>

2.2 Installing/importing the pack

2.2.1 Add from local file

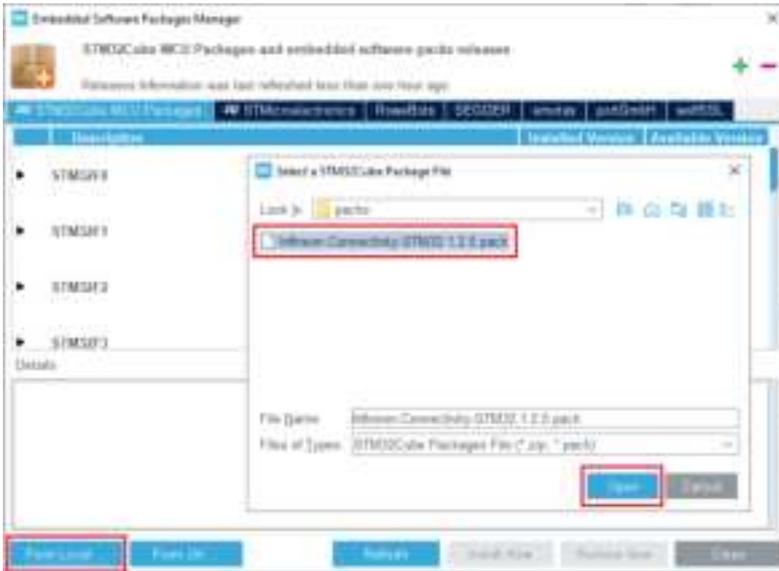
Perform these steps to add the expansion pack to the STM32 development environment:

1. Run the STM32CubeMX tool.
2. Navigate to **Home > Manage software installations** and select **Install/Remove**.



Download/install/import expansion pack

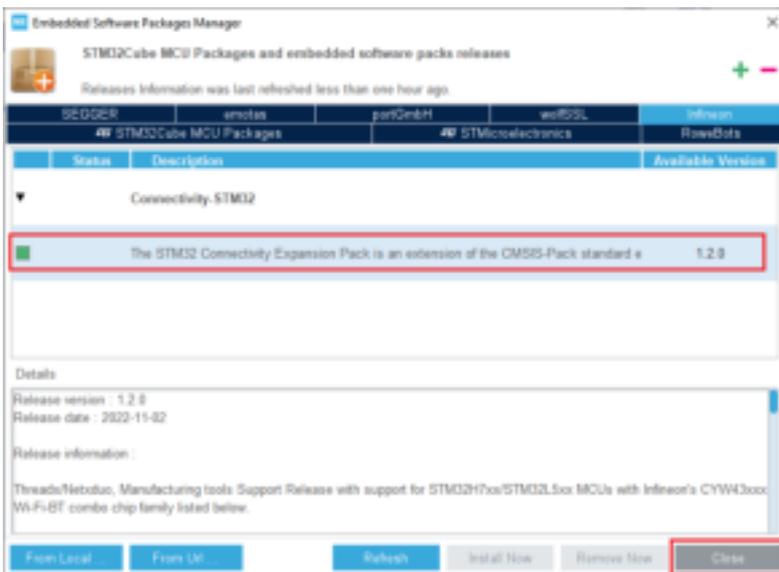
3. Select **From Local...**, navigate to the downloaded pack file, and select **Open**.



4. Accept the license agreement and select **Finish**.



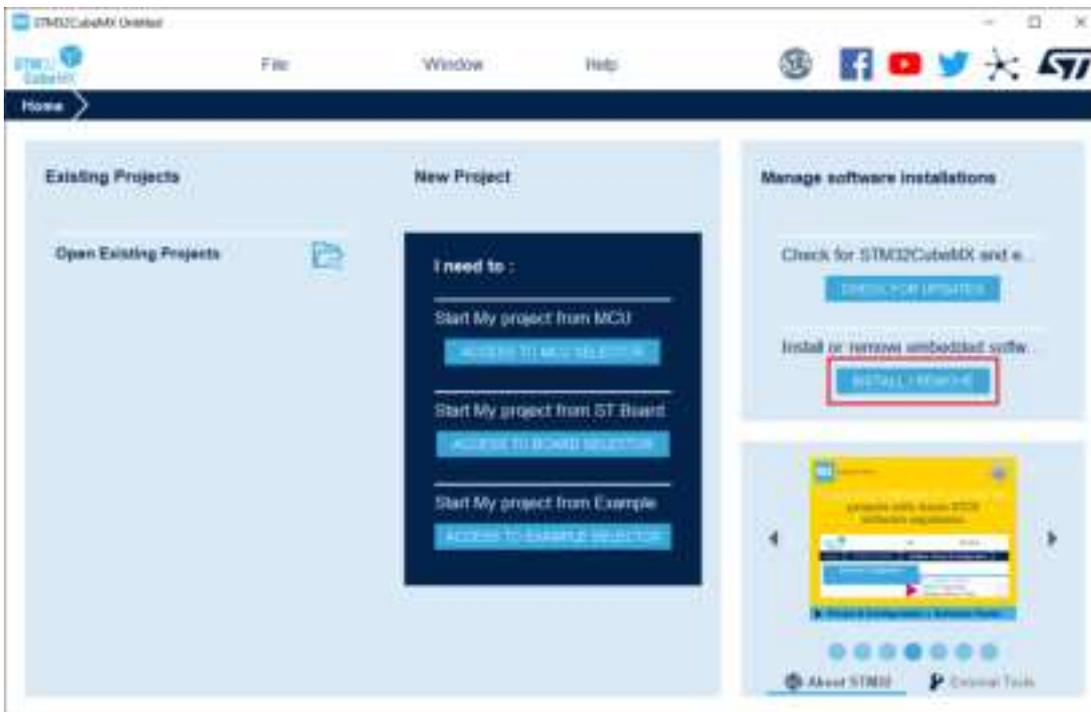
5. The tool shows an **Infineon** tab with the installed Expansion Pack displayed. Click **Close**.



Download/install/import expansion pack

2.2.2 Add the Pack from URL

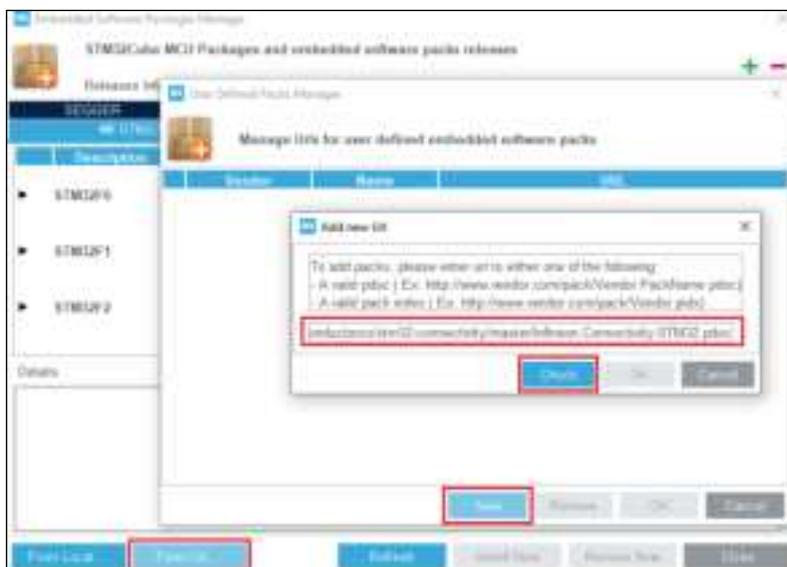
1. Run the STM32CubeMX tool.
2. Navigate to **Home > Manage software installations** and select **Install/Remove**.



3. Select From URL...
4. Select **New (URL)**.
5. Input the GitHub URL to PDSC-file:

<https://raw.githubusercontent.com/cypresssemiconductorco/stm32-connectivity/master/Infineon.Connectivity-STM32.pdsc>

6. Click **Check** and **OK** if check is successful.



Download/install/import expansion pack

7. Select the just added URL and confirm with **OK** button.



8. In the Software Package Manager select the pack and click **Install Now** to start online installation.



Hardware setup

3 Hardware setup

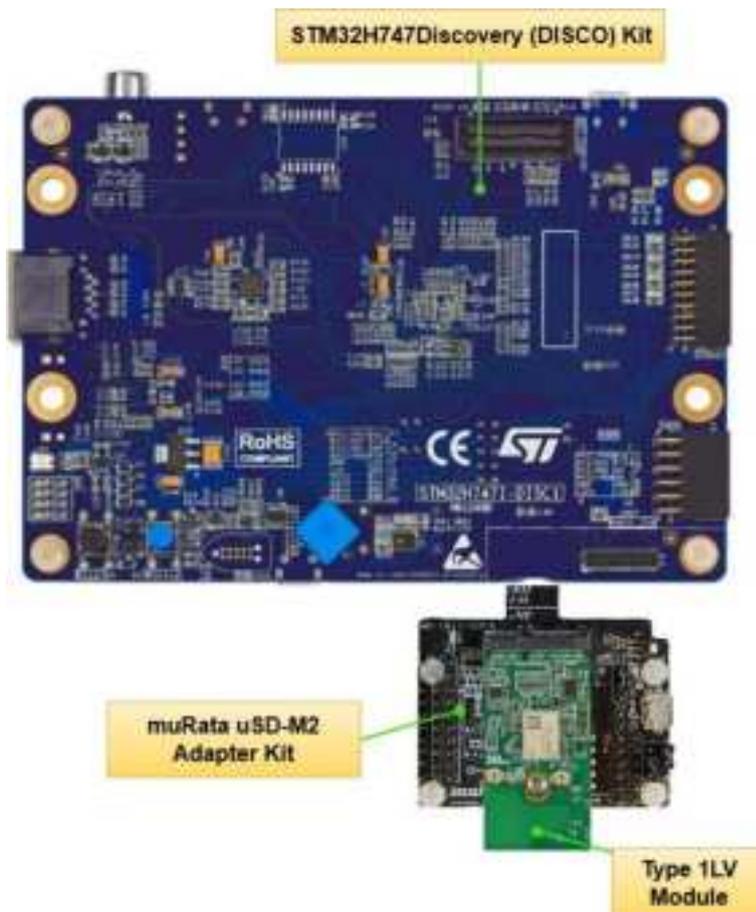
3.1 Using STM32H747 DISCO kit

STM32H747 Disco Kit setup requires three discrete boards to create a setup where an STM32H747 hosts Infineon's CYW43xxx connectivity device. The three boards and links are:

- [STM32H747 Discovery \(DISCO\) Kit](#): The STM32H747I-DISCO Discovery kit is a complete demonstration and development platform for STMicroelectronics STM32H747XIH6 microcontroller, designed to simplify user application development.
- [muRata uSD-M2 Adapter Kit \(rev B1\)](#): muRata's uSD-M.2 Adapter Kit with Embedded Artists' Wi-Fi/Bluetooth® M.2 Modules enable users with a simple plug-in solution. The Embedded Artists' Wi-Fi/Bluetooth® M.2 Modules are based on Murata modules using Infineon's Wi-Fi/Bluetooth® chipsets.

Current Wi-Fi/Bluetooth® EVB support include

- Murata Type 1DX M.2 (CYW4343W)
- Type 1MW (CYW43455)
- Type 1LV M.2 (CYW43012)
- [Embedded Artists 1LV M.2 Module](#): Embedded Artists Type 1LV M.2 EVB is designed to work with the Murata uSD-M.2 Adapter.



Hardware setup

3.1.1 Set up type 1LV M.2 module

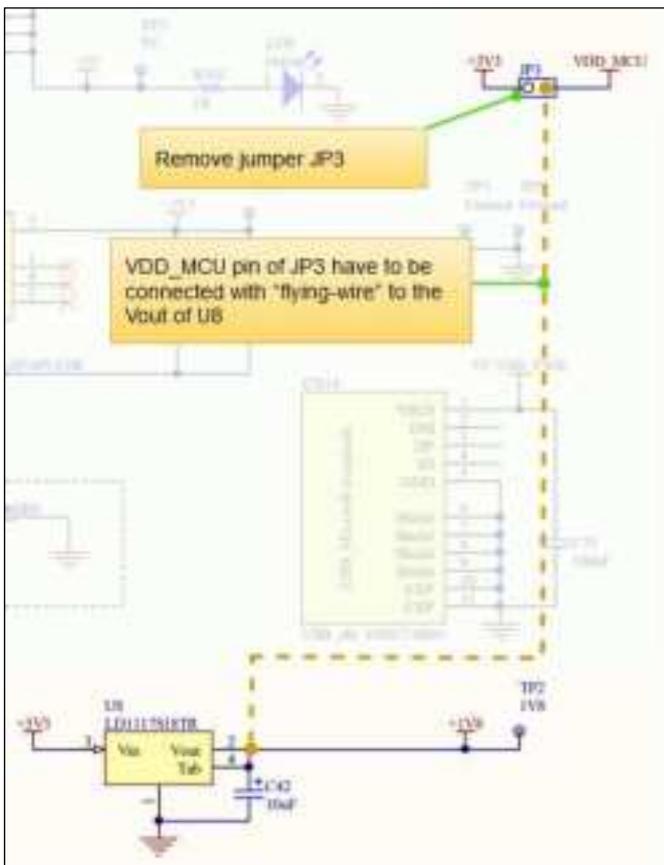
Model	Embedded Artists 1LV M.2 Module	
Features	<ul style="list-style-type: none"> 802.11 a/b/g/n/ac-friendly™ and Bluetooth/LE 5.0 SDIO 3.0 interface, SDR40@80MHz Chipset: Infineon CYW43012 	
Datasheet	1LV M.2	

3.1.1.1 Board preparations

The 1LV module operates at 1.8 V VIO only (chipset limitation). The following preparation on STM32H747 DISCO Kit and muRata uSD-M2 Adapter are required:

1. Modify STM32H747 Disco Kit to operate on 1.8 V.

Remove the jumper JP3 and connect the VDD_MCU pin of JP3 with "flying-wire" to the Vout of U8 linear voltage regulator (which is effectively a 1.8 V source).

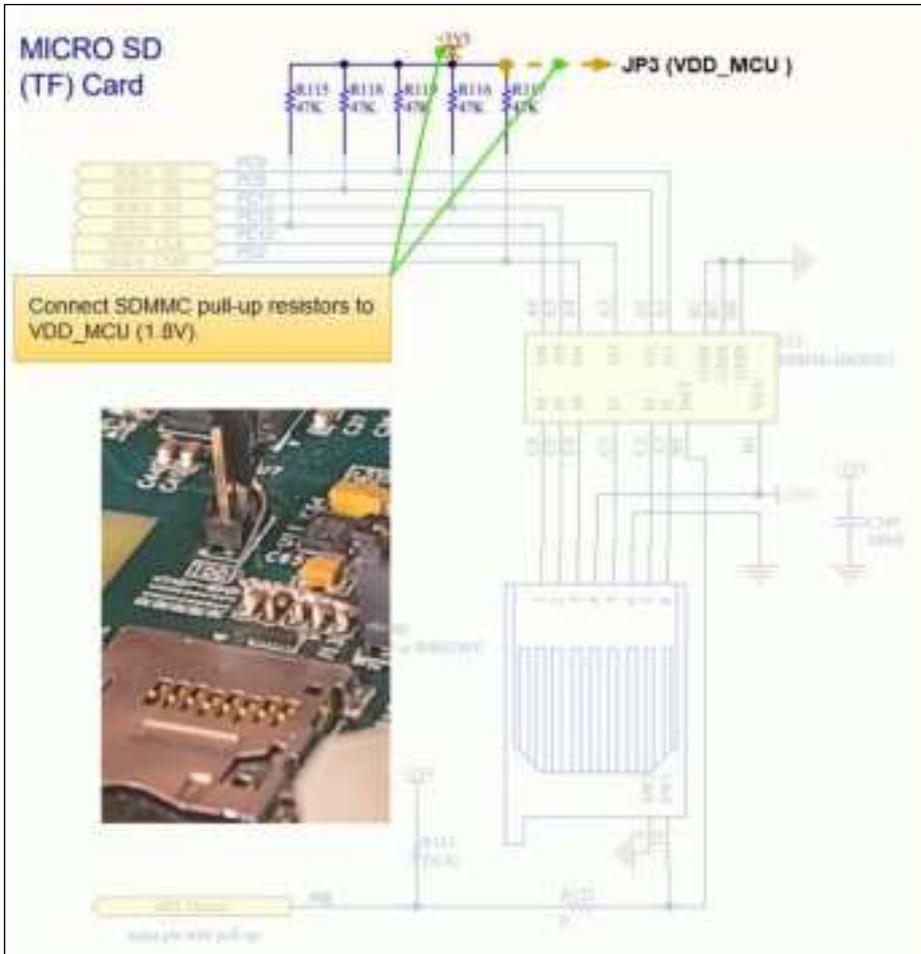


Note: Switching STM32H747 Disco Kit to operate on 1.8 V affects the functionality of external flash (MT25QL512ABB8ESF).

Hardware setup

2. Connect SDMMC pull-up resistors to VDD_MCU (1.8V) on STM32H747 DISCO Kit.

SDMMC pull-up resistors R115-R119 must be unsoldered from the 3.3 V point and soldered vertically. The tops of these resistors have to be soldered to "flying-wire" and connected to JP3 at the side of VDD_MCU.



3. Modify muRata uSD-M2 Adapter to operate on 1.8V.

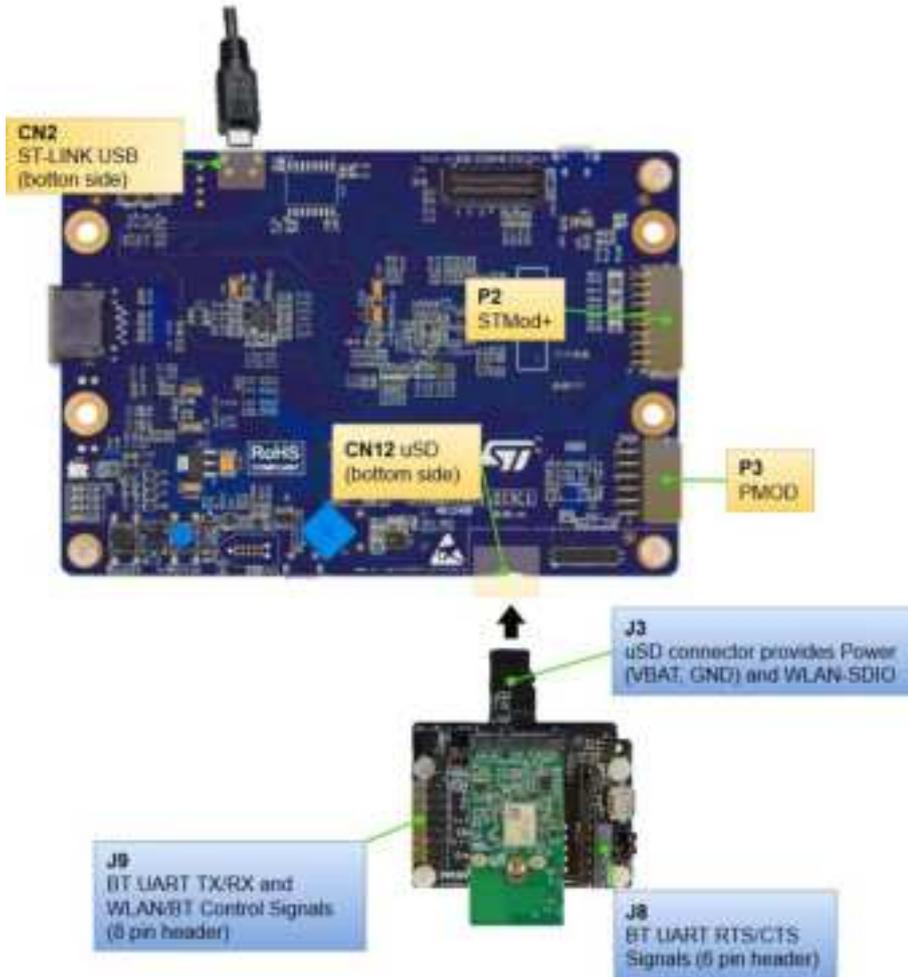
To switch muRata uSD-M2 Adapter to 1.8V the following jumpers have to be configured:

- J1 to pos 2-3 to powered USD_3V3 from uSD VCC
- J12 to pos 1-2 (M2 IO Voltage for 1.8V VDDIO)
- J13 to pos 2-3 (Host IO Voltage for 1.8V)



Hardware setup

3.1.1.2 Wire connections



Connection	Operation	STM32H747 Disco Kit		muRata uSD-M2 Adapter	Note
		Connector	STM32 GPIO		
VBAT (3.3V)	VCC	CN12		J3	VBAT, GND connected via microSD connector
GND	GND				
WL_REG_ON_HOST	Wi-Fi	P3.7 (PMOD#11)	PC6	J9.3	Enables/Disables WLAN core: Active High
WL_HOST_WAKE_HOST	Wi-Fi	P3.8 (PMOD#12)	PJ13	J9.5	WLAN Host Wake: Active Low (OOB IRQ)
SDIO	Wi-Fi	CN12	PC8, PC9, PC10, PC11, PC12, PD2	J3	uSD connector pin provides Power (VBAT, GND) and WLAN-SDIO (DATA1, DATA2, DATA3, Clock and Command)
UART RX	Bluetooth	P3.1 (PMOD#1)	PA11	J9.1	UART
UART TX	Bluetooth	P3.4 (PMOD#4)	PA12	J9.2	
UART CTS	Bluetooth	P2.8 (STmod+)	PB15	J8.3	
UART RTS	Bluetooth	P2.9 (STmod+)	PB14	J8.4	
BT_REG_ON	Bluetooth	P2.10 (STmod+)	PD13	J9.4	Enables/Disables Bluetooth® core: Active High

Hardware setup

3.1.2 Set up type 1DX M.2 module

Model	Embedded Artists 1DX M.2 Module	
Features	<ul style="list-style-type: none"> • 802.11 b/g/n and Bluetooth/LE 4.2 • SDIO 2.0 interface, SDR25@50MHz • Chipset: Infineon CYW4343W 	
Datasheet	1DX M.2	

3.1.2.1 Board preparations

This module does not require the host to provide 1.8 V on the SDIO/UART GPIO. It can operate on 3.3V/1.8V. This makes board preparation simpler. Please see the following sections

1. Modify muRata uSD-M2 Adapter to operate on 3.3V.

To switch muRata uSD-M2 Adapter to 3.3V the following jumpers have to be configured:

- J1 to pos 2-3 to powered USD_3V3 from uSD VCC
- J12 to pos 2-3 (M2 IO Voltage for 3.3V VDDIO)
- J13 to pos 1-2 (Host IO Voltage for 3.3V VDDIO)



3.1.2.2 Wire connections

The Type 1DXM module uses the same wire connections as Type 1LV modules. Refer to the [Wire connections](#) section for Type 1LV Modules.

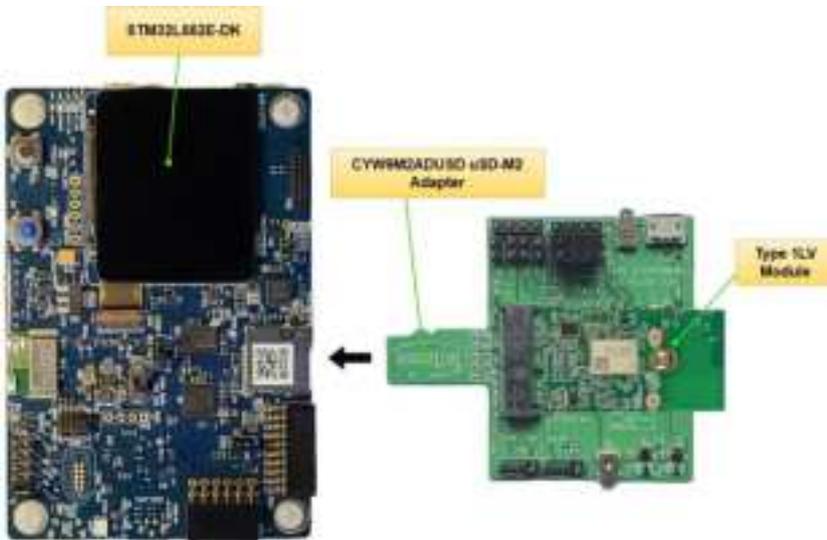
Hardware setup

3.2 Using STM32L562E-DK

3.2.1 Set Up M.2 Module + CYW9M2ADUSD Adapter Kit for Wi-Fi and Bluetooth® Connectivity

STM32L562E DK Kit setup for Bluetooth® connectivity requires three discrete boards to create a setup where an STM32L562E hosts Infineon's CYW43xxx connectivity device. The three boards and links are:

- [STM32L562E-DK](#) Discovery kit is a complete demonstration and development platform for Arm® Cortex®-M33 with Arm® TrustZone® and ARMv8-M mainline security extension core-based STM32L562QEI6QU microcontroller, with 512 Kbytes of Flash memory and 256 Kbytes of SRAM.
- [CYW9M2ADUSD Adapter Kit](#): adapter which allows you to connect M.2-based CYW43x connectivity modules into SD-card slot of a various DVKs and EVKs. Please contact sales for order questions.
- [Embedded Artists 1LV M.2 Module](#): Embedded Artists Type 1LV M.2 EVB is designed to work with the Murata uSD-M.2 Adapter.



3.2.1.1 Board preparation

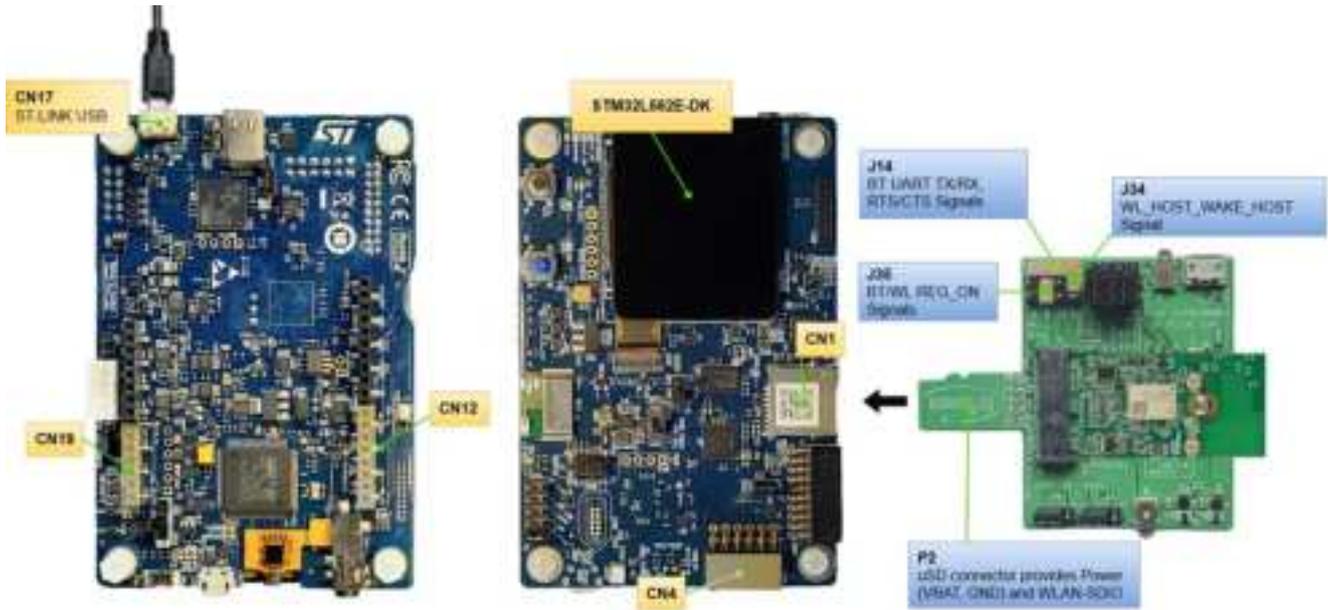
CYW9M2ADUSD Adapter requires to configure the following jumpers:

- J6 and J8 to pos 2-3 (use 3.3V from VDD_SDIO)
- J33 to use 1.8V level shifters for UART
- SW1 – switches 1 and 2 in OFF position



Hardware setup

3.2.1.2 Wire connections



Connection	Operation	STM32L562E-DK		CYW9M2ADUSD Adapter	Note
		Connector	STM32 GPIO		
VBAT (3.3V)	VCC	CN1		P2 (uSD Connection)	VBAT, GND connected via microSD connector
GND	GND				
WL_REG_ON_HOST	Wi-Fi	CN4.7	PF5	J35.1	Enables/Disables WLAN core: Active High
WL_HOST_WAKE_HOST	Wi-Fi	CN4.1	PB13	J34.1	WLAN Host Wake: Active Low (OOB IRQ)
SDIO	Wi-Fi	CN1	PC8, PC9, PC10, PC11, PC12, PD2	P2 (uSD Connection)	uSD connector pins: provides Power (VBAT, GND) and WLAN-SDIO (DATA0, DATA1, DATA2, DATA3, Clock and Command)
BT_REG_ON	Bluetooth	CN12.5	PF4	J35.2	Enables/Disables Bluetooth® core: Active High
UART RX	Bluetooth	CN19.6	PC5	J14.2 (TX)	UART (USART3)
UART TX	Bluetooth	CN12.1	PB10	J14.1 (RX)	
UART CTS	Bluetooth	CN12.3	PD11	J14.4 (RTS)	
UART RTS	Bluetooth	CN12.4	PD12	J14.3 (CTS)	

Hardware setup

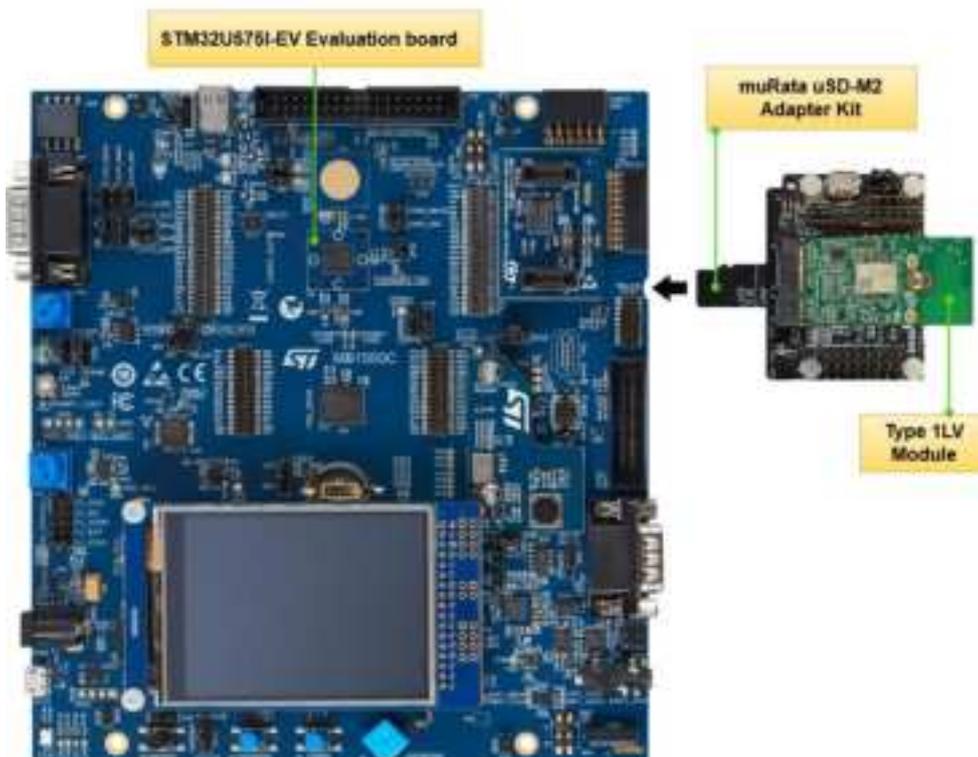
3.3 Using STM32U575I-EV Evaluation board

The STM32U575I-EV Evaluation board setup requires three discrete boards to enable the STM32U575 board to host Infineon's CYW43xxx connectivity device. The three boards and links are:

- [STM32U575I-EV Evaluation board](#): This board is a complete demonstration and development platform for STMicroelectronics STM32U575AI16Q microcontroller, designed to simplify user application development.
- [muRata uSD-M2 Adapter Kit \(rev B1\)](#): muRata's uSD-M.2 Adapter Kit with Embedded Artists' Wi-Fi/Bluetooth® M.2 Modules enable users with a simple plug-in solution. The Embedded Artists' Wi-Fi/Bluetooth® M.2 Modules are based on Murata modules using Infineon's Wi-Fi/Bluetooth® chipsets.

Current Wi-Fi/Bluetooth® EVB support include

- Murata Type 1DX M.2 (CYW4343W)
 - Type 1MW (CYW43455)
 - Type 1LV M.2 (CYW43012)
- [Embedded Artists 1LV M.2 Module](#): Embedded Artists Type 1LV M.2 EVB is designed to work with the Murata uSD-M.2 Adapter.



Hardware setup

3.3.1 Set up type 1LV M.2 module

3.3.1.1 Board preparations

The 1LV module operates at 1.8 V VIO only (chipset limitation). The following preparation on STM32U575I-EV Evaluation board and muRata uSD-M2 Adapter are required:

1. Modify the STM32U575I-EV Evaluation board to operate on 1.8 V.

By default, the STM32U575I-EV Evaluation board is configured with VDD_MCU at 3.3 V. To switch the board to 1.8V:

- Use a potentiometer RV3 to adjust VDD_ADJ to 1.8V. You can use TP29 as test point for the Voltmeter connection.
- Configure JP23 to pos 2-3. It switches VDD/VDD_MCU to VDD_ADJ instead of 3.3V

Note: Switching the STM32U575I-EV Evaluation board to operate on 1.8 V affects the functionality of external flash (MT25QL512ABB8ESF) and external SRAM (IS61WV102416BLL-10MLI).

2. Modify the muRata uSD-M2 Adapter to operate on 1.8 V.

To switch the muRata uSD-M2 Adapter to 1.8 V, configure the following jumpers:

- J1 to pos 1-2 to powered USD_3V3 from micro USB (J2)
- J12 to pos 1-2 (M2 IO Voltage for 1.8V VDDIO)
- J13 to pos 2-3 (Host IO Voltage for 1.8 V)
- Micro USB (J2) should be plugged in.

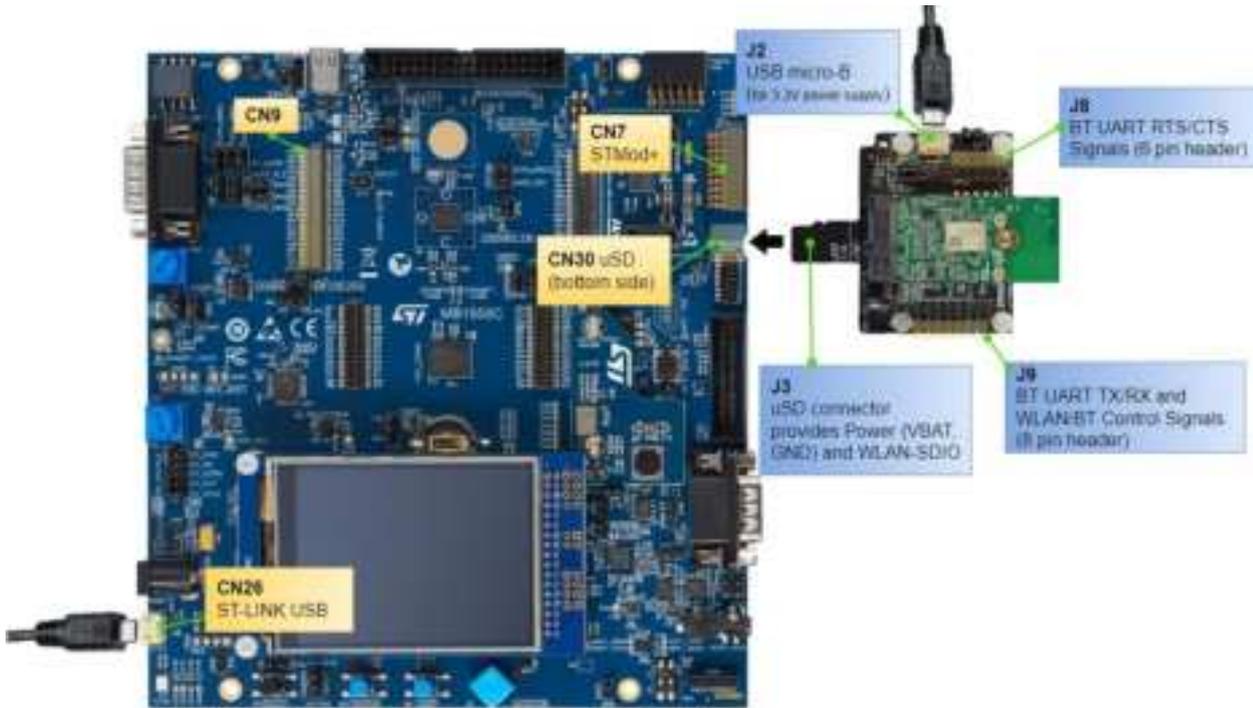


3. Configure jumpers on the STM32U575I-EV Evaluation board:

- Remove JP10
- Remove JP11
- Remove JP12
- Remove SB38 is shorted (default)

Hardware setup

3.3.1.2 Wire connections



Connection	Operation	STM32U5751-EV		muRata uSD-M2 Adapter	Note
		Connector	STM32 GPIO		
VBAT (3.3V)	VCC	CN30		J3	VBAT, GND connected via microSD connector
GND	GND				
WL_REG_ON_HOST	Wi-Fi	CN7.9 (STmod+)	PB4	J9.3	Enables/Disables WLAN core: Active High
WL_HOST_WAKE_HOST	Wi-Fi	CN7.8 (STmod+)	PB5	J9.5	WLAN Host Wake: Active Low (OOB IRQ)
SDIO	Wi-Fi	CN30	PC8, PC9, PC10, PC11, PC12, PD2	J3	uSD connector pin provides Power (VBAT, GND) and WLAN-SDIO (DATA1, DATA2, DATA3, Clock and Command)
UART RX	Bluetooth	CN9.13	PG8	J9.1	UART (LPUART1)
UART TX	Bluetooth	CN9.12	PG7	J9.2	
UART CTS	Bluetooth	CN9.24	PB13	J8.3	
UART RTS	Bluetooth	CN9.11	PG6	J8.4	
BT_REG_ON	Bluetooth	CN7.10 (STmod+)	PB11	J9.4	Enables/Disables Bluetooth® core: Active High

Hardware setup

3.3.2 Set up type 1DX M.2 module

3.3.2.1 Board preparations

This module does not require the host to provide 1.8 V on the SDIO/UART GPIO. It can operate on 3.3 V/1.8 V. This makes board preparation simpler.

1. Modify the muRata uSD-M2 Adapter to operate on 3.3 V.

To switch the muRata uSD-M2 Adapter to 3.3V, configure the following jumpers:

- J12 to pos 2-3 (M2 IO Voltage for 3.3V VDDIO)
- J13 to pos 1-2 (Host IO Voltage for 3.3V VDDIO)



3.3.2.2 Wire connections

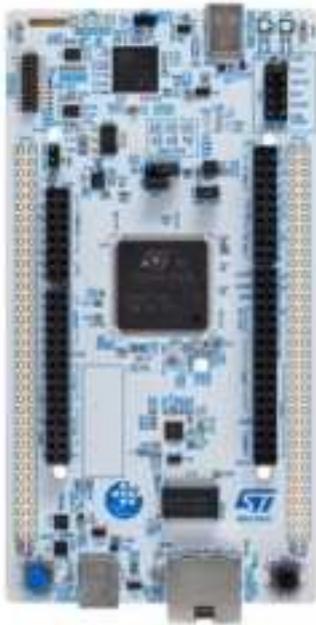
The Type 1DXM module uses the same wire connections as the Type 1LV modules. Refer to the [Wire connections](#) section (3.3.1.2) for Type 1LV Modules.

Hardware setup

3.4 Using NUCLEO-H563ZI board

The NUCLEO-H563ZI board setup requires three discrete boards to enable the STM32H5xx board to host Infineon's CYW43xxx connectivity device. The three boards and links are:

- [NUCLEO-H563ZI board](#): This board is a complete demonstration and development platform for STMicroelectronics STM32U575AII6Q microcontroller, designed to simplify user application development.
- Infineon NUCLEO 144 Expansion Board: This Board enables users to connect M.2 Module to NUCLEO-H563ZI Board
- [Embedded Artists 1LV M.2 Module](#): Embedded Artists Type 1LV M.2 EVB is designed to work with the Murata uSD-M.2 Adapter.



Using example projects

4 Using example projects

We provide the following example projects to get started using the pack:

- [Wi-Fi Scan](#)
- [Wi-Fi onboarding with Bluetooth® LE](#)
- [Azure RTOS NetXDuo Wi-Fi UDP echo server](#)
- [Bluetooth® LE Hello Sensor](#)
- [Wi-Fi TCP keepalive offload](#)

4.1 Wi-Fi Scan

This example demonstrates how to configure different scan filters provided in the Wi-Fi Connection Manager (WCM) middleware and scan for the available Wi-Fi networks.

The example initializes the Wi-Fi device and starts a Wi-Fi scan without any filter and prints the results on the serial terminal. The example starts a scan every three seconds after the previous scan completes.

This example demonstrates how an STM32H7 can be used to host CYW43xxx connectivity devices.

4.1.1 Hardware

Refer to the section on the STM32 hardware configuration descriptions as appropriate:

- [Using STM32H747 DISCO Kit](#)

4.1.2 Other software

Install a terminal emulator if you do not have one. Instructions in this document use [Tera Term](#).

4.1.3 Project components

The following are the only components used in this project:

- Wifi/network-interface (configured as LWIP)
- Wifi/wifi-host-driver (WHD)
- Wifi/wcm
- Wifi/whd-bsp-integration
- Wifi/connectivity-utilities
- Wifi/LwIP
- Platform/pal (PAL, HAL, core-lib)
- Platform/abstraction-rtos (configured for the FreeRTOS kernel)
- Platform/device (configured as CYW43012)

Using example projects

4.1.4 Example project start/import

You can open the Wi-Fi Scan example by copying the example from the Pack to an appropriate location. Once you have copied the example, you can then open it in STM32CubeMX and export to your IDE using the following steps:

1. Copy the code example from the pack directory to your local directory.

The default path for installed packs is:

```
C:\Users\<USER>\STM32Cube\Repository\Packs\
```

Copy the `wifi_scan` example from the appropriate directory. For instance, for STM32H747I-DISCO:

```
C:\Users\<USER>\STM32Cube\Repository\Packs\Infineon\Connectivity-STM32\1.3.0\Projects\STM32H747I-DISCO\Applications\wifi_scan
```

Paste into your working folder. For example:

```
C:\Users\<USER>\STM32Cube\Example
```

2. Open `wifi_scan.ioc` file in the root folder of project.

```
C:\Users\<USER>\STM32Cube\Example\wifi_scan\wifi_scan.ioc
```

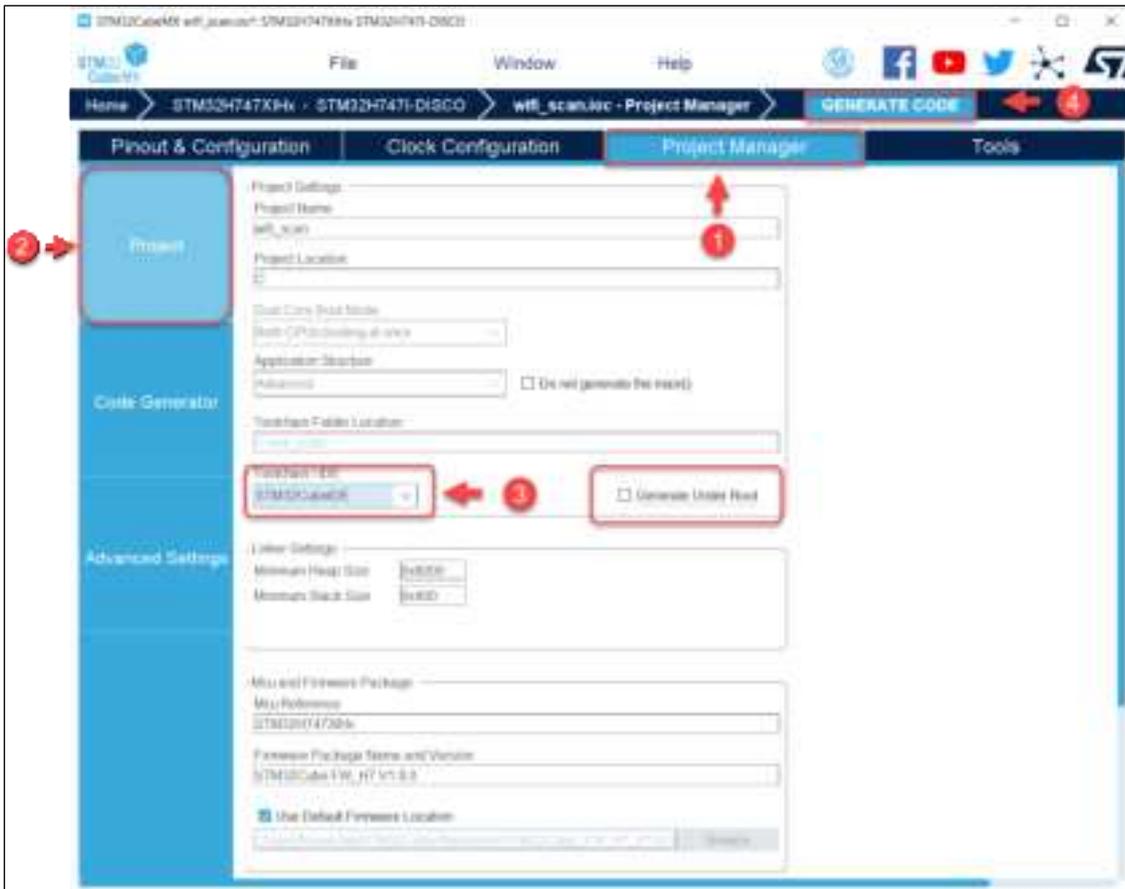
3. Click **OK** to accept.

Using example projects

4.1.5 Generate code

Follow these steps to generate code:

1. Select **the Project Manager** tab.
2. Select **Project**.
3. Select the appropriate option under **Toolchain / IDE** and select the **Generate Under Root** check box.
4. Click **GENERATE CODE**.



If a message displays about missing packages, select **Yes**:



5. After the code is generated, you will see this dialog. Select **Open Project**.

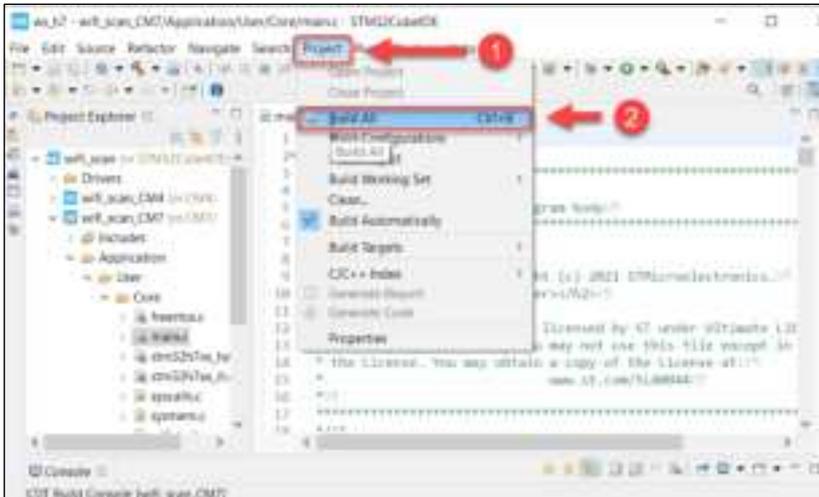


Using example projects

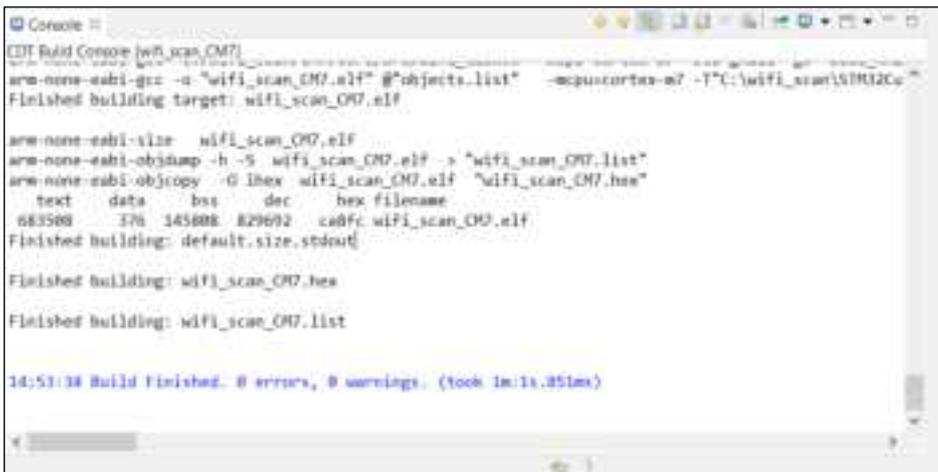
4.1.6 Build the project

The build step and expected output are illustrated here for each IDE.

4.1.6.1 STM32CubeIDE:

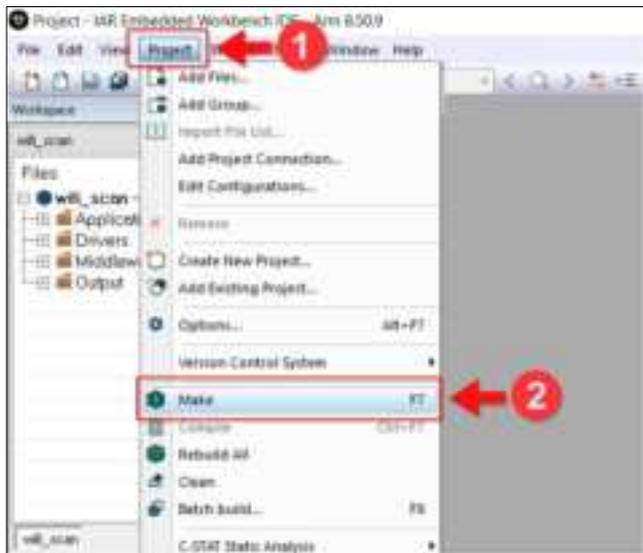


Example output from a successful build:

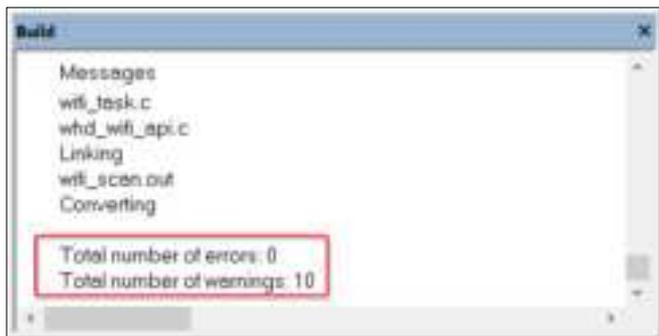


Using example projects

4.1.6.2 IAR EWARM:



The project should build without errors. There are 10 warnings in the lwIP library.



4.1.7 Project hardware setup

Refer to section [Hardware Setup](#).

4.1.8 Terminal display

The terminal display is used by the application to provide status and network information.

You will need a terminal emulator such as Tera Term (<https://tssh2.osdn.jp/index.html.en>) to display the output.

4.1.8.1 Serial terminal setup

The terminal interface is a virtual COM port which is part of the ST-LINK (CN2) USB connection. Terminal emulator configuration:

- Baud Rate: 115200
- Data Length: 8 Bits
- Stop Bit(s): 1
- Parity: None
- Flow control: None

Using example projects

4.1.8.2 Example output

```
***** WiFi-Scan app *****

Insert CYW43xxx into microSD card slot

Push blue button to continue...

CYW43xxx detected

WLAN MAC Address : E8:E8:B7:9F:CC:EAWLAN Firmware : wl0: Sep  9 2020 01:22:10 version 13.10.271.253
(c4c4c7c CY) FWID 01-79301becWLAN CLM : API: 18.2 Data: 9.10.0 Compiler: 1.36.1 ClmImport:
1.34.1 Creation: 2020-09-09 01:19:03 WHD VERSION : v1.93.0 : v1.93.0 : IAR 8050009 : 2020-12-21
13:24:03 +0530
-----
#          SSID          RSSI  Channel  MAC Address      Security
-----
1  Private          -72    11     1C:AF:F7:26:8D:A8  WPA2_MIXED_PSK
2  Private          -73    11     74:DA:88:29:F2:27  WPA2_MIXED_PSK
-----
#          SSID          RSSI  Channel  MAC Address      Security
-----
1  Private          -68    11     74:DA:88:29:F2:27  WPA2_MIXED_PSK
2  Private          -73    11     1C:AF:F7:26:8D:A8  WPA2_MIXED_PSK
```

4.2 Wi-Fi onboarding with Bluetooth® LE

This example uses the STM32H7 MCU to communicate with the CYW43xxx combo devices and control the Wi-Fi and Bluetooth® LE functionality. It uses Bluetooth® LE on the combo device to help connect the Wi-Fi to the AP.

In this example, Bluetooth® LE provides a mechanism for the device to connect to a Wi-Fi AP by providing the Wi-Fi SSID and password in a secure manner. The Wi-Fi credentials are stored in EEPROM so that the device can use this data upon reset to connect to an AP without requiring Bluetooth® LE intervention. Note that the data stored in the EEPROM is unencrypted.

The Wi-Fi SSID and password are exchanged using custom GATT service and characteristics. There is a third custom characteristic, which gives the command to connect and disconnect. The Wi-Fi password is write-only; the device needs to be paired before this characteristic can be written.

Bluetooth® LE GATT Custom Service This example uses custom GATT service and characteristics to communicate with the Bluetooth® LE GATT client. The files `cycfg_gatt_db.c` and `cycfg_gatt_db.h` contain the GATT DB.

The following custom characteristics are used in this example:

- **Wi-Fi SSID:** Provides the Wi-Fi SSID from Bluetooth® LE GATT client to the server. The maximum size is 32 as Wi-Fi limits the SSID name to 32 characters.
- **Wi-Fi Password:** Provides the Wi-Fi password from the Bluetooth® LE GATT client to the server. The minimum size is 8 because Wi-Fi encryption requires a minimum of 8 characters for password.
- **Wi-Fi Connect:** A Boolean characteristic that is used to connect and disconnect from the Wi-Fi AP. This has a Client Characteristic Configuration Descriptor (CCCD) attached with it. Whenever there is a successful connection it will send a notification value of 1 otherwise it will send a notification value of 0 if notifications are enabled.

4.2.1 Hardware

Refer to section the STM32 hardware configuration descriptions as appropriate:

- [Using STM32H747 DISCO Kit](#)

Using example projects

4.2.2 Other software

This code example requires two devices: Host (Mobile Phone or PC) and a Target (STM32H747 DISCO Kit).

For the Host, download and install the AIROC™ Bluetooth® Connect App for iOS or Android. The AIROC™ Bluetooth® Connect App - iOS and Android versions are available for download on the [App Store](#) and [Google Play](#) store respectively.

Install a terminal emulator if you don't have one. Instructions in this document use [Tera Term](#).

4.2.3 Project components

The following are the components used in this project:

- Wifi/network-interface (configured as LWIP)
- Wifi/wifi-host-driver (WHD)
- Wifi/wcm
- Wifi/whd-bsp-integration
- Wifi/connectivity-utilities
- Wifi/LwIP
- Bluetooth/btstack
- Bluetooth/btstack-integration
- Platform/pal (PAL, HAL, core-lib)
- Platform/abstraction-rtos (configured for the FreeRTOS kernel)
- Platform/device (configured as CYW43012)

4.2.4 Example project start/import

You can open the Wi-Fi Onboarding with Bluetooth® LE example by copying the example from the Pack to an appropriate location:

```
C:\Users\<USER>\STM32Cube\Repository\Packs\Infineon\Connectivity-STM32\1.3.0\Projects\STM32H747I-DISCO\Applications\Bluetooth® LE_wifi_onboarding
```

Once you have copied the example, you can then open it in STM32CubeMX and export to your IDE using the following steps from [Example project start/import](#). [Generate code](#), [Build the project](#) from [Wi-Fi Scan](#) example.

4.2.5 Project hardware setup

Refer to section [Hardware Setup](#).

4.2.6 Operation

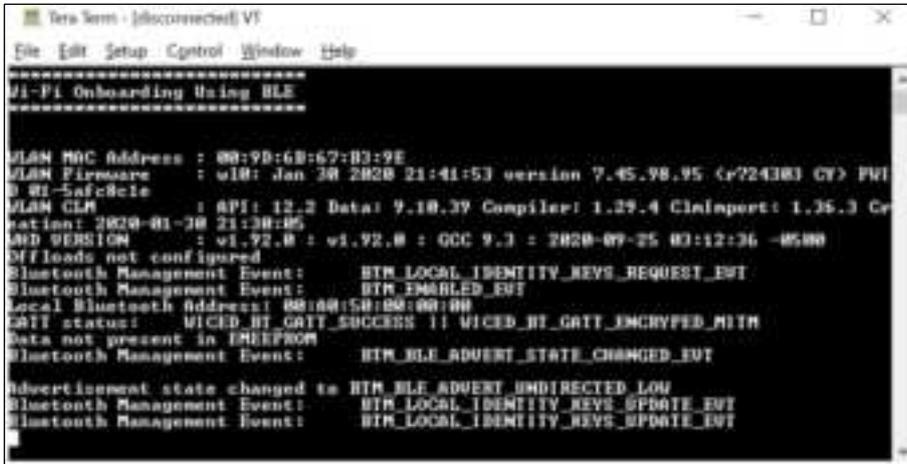
1. Connect the STM32H747 DISCO Kit to your PC.
2. Use your favorite serial terminal application and connect to the ST-LINK (CN2) COM port. Configure the terminal application to access the serial port using the following settings.

Baud rate: 115200 bps; Data: 8 bits; Parity: None; Stop: 1 bit; Flow control: None; New line for receive data: Line Feed (LF) or Auto setting

Using example projects

3. Program the board.

After programming, the application starts automatically. Observe the messages on the UART terminal, and wait for the device to make all the required connections.



```

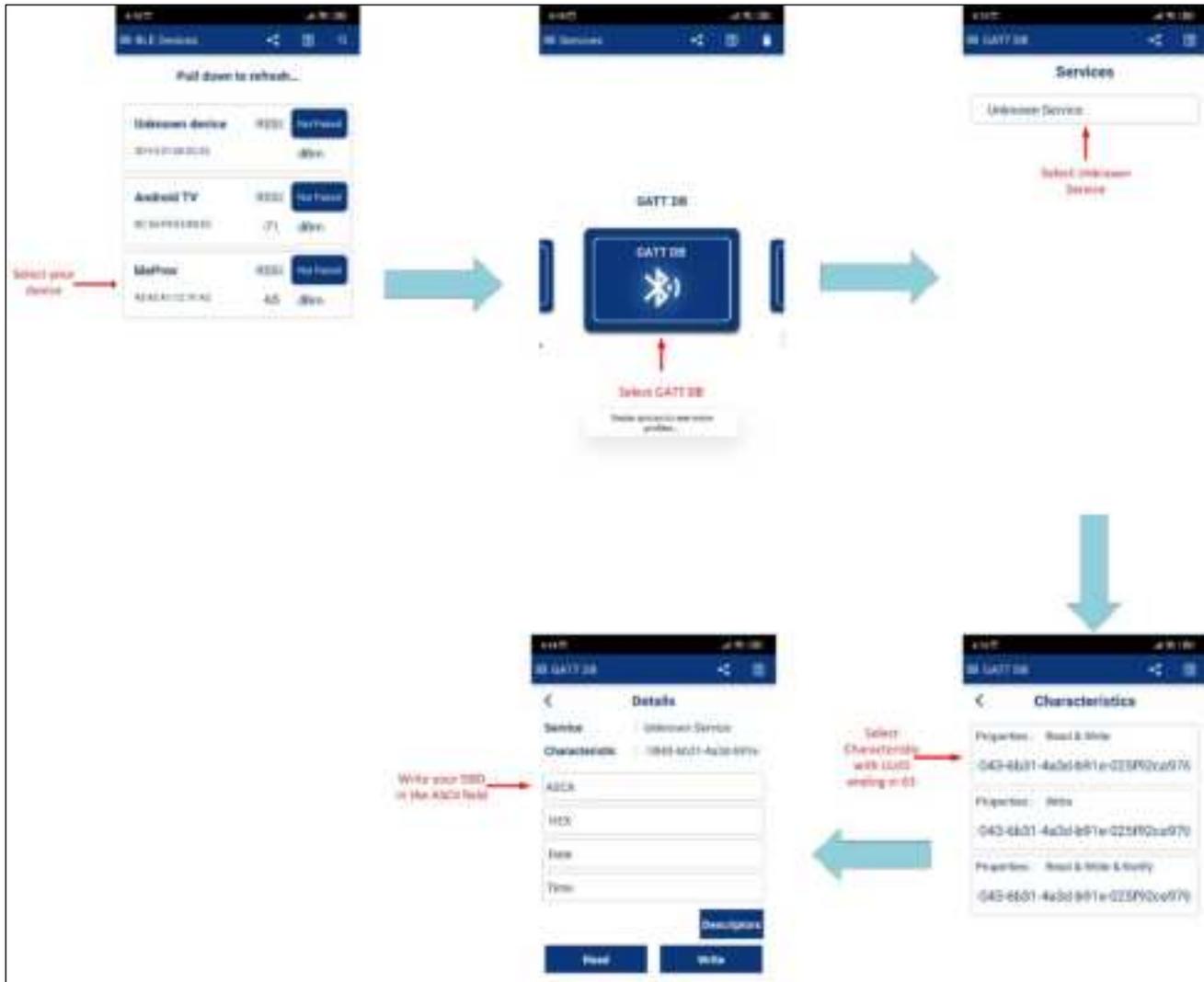
Termin - [disconnected] V1
File Edit Setup Control Window Help
*****
Wi-Fi Onboarding Using BLE
*****
WLAN MAC Address : 00:9D:68:67:03:9E
WLAN Firmware   : w10: Jan 30 2020 21:41:53 version 7.45.98.95 (r224303 CY) PVI
B WI-5af8c1e
WLAN CLM        : API: 12.2 Data: 9.10.39 Compiler: 1.29.4 Claimert: 1.35.3 Cr
ation: 2020-01-30 21:38:05
WLAN VERSION    : v1.92.0 : v1.92.0 : GCC 9.3 : 2020-09-25 03:12:36 -W500
Offloads not configured
Bluetooth Management Event: BTM_LOCAL_IDENTITY_KEYS_REQUEST_EVT
Bluetooth Management Event: BTM_ENABLED_EVT
Local Bluetooth Address: 00:9D:68:67:03:9E
GATT status: WICED_BT_GATT_SUCCESS || WICED_BT_GATT_ENCRYPTED_WITH
Data not present in EEPROM
Bluetooth Management Event: BTM_BLE_ADVERT_STATE_CHANGED_EVT

Advertisement state changed to BTM_BLE_ADVERT_UNDIRECTED_LOW
Bluetooth Management Event: BTM_LOCAL_IDENTITY_KEYS_UPDATE_EVT
Bluetooth Management Event: BTM_LOCAL_IDENTITY_KEYS_UPDATE_EVT
    
```

4. To test using the AIROC™ Bluetooth® Connect App mobile app, do the following

- a. Turn ON Bluetooth® on your Android or iOS device.
- b. Launch the app.
- c. Press the reset switch on the kit to start sending advertisements.
- d. Swipe down on the app home screen to start scanning for Bluetooth® LE Peripherals. Your device ("bleProv") appears in the app home screen. Select your device to establish a Bluetooth® LE connection.
- e. Select the **GATT DB** Profile from the carousel view then select **Unknown Service**.
- f. Select the attribute with the UUID ending in 63. In the ASCII field, type your Wi-Fi SSID in string format. Do the same for password UUID ending in 64) as described above.

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5. Select the attribute with the UUID ending in 65. Select **Notify**. Write hex value 1 to this characteristic to connect to the Wi-Fi network. If the connection is successful then the server will send a notification with the value 1 or with the value 0.

```

COM9 - Tera Term V1
File Edit Setup Control Window Help
Advertisement state changed to BTM_BLE_ADVERT_OFF
Exchanged MIU from client: 512
GATT Read handler: handle:0x3, len:7
Bluetooth Management Event: BTM_SECURITY_REQUEST_EVT
Bluetooth Management Event: BTM_PAIRING_IO_CAPABILITIES_BLE_REQUEST_EVT
Bluetooth Management Event: BTM_PAIRING_COMPLETE_EVT
Pairing Complete: SUCCESS
Bluetooth Management Event: BTM_ENCRYPTION_STATUS_EVT
Encryption Status Event: SUCCESS
GATT write handler: handle:0x9 len:7
WiFi SSID:
GATT Read handler: handle:0x9, len:7
GATT write handler: handle:0xC len:11
WiFi Password:
GATT write handler: handle:0xF len:1
Starting scan with SSID: Abhiraj
GATT Read handler: handle:0xF, len:1
CY_WCM_SECURITY_WPA2_RES_PSK
CY_WCM_SECURITY_WPA2_RES_PSK

Trying to connect SSID: . Password:
Successfully joined the Wi-Fi network
Notification not sent
    
```

Once the Wi-Fi SSID and password are provided by the client it is stored in the EEPROM. To delete this data the user needs to press the User Button.

Using example projects

4.3 Azure RTOS NetXDuo Wi-Fi UDP echo server

This application provides an example of Azure RTOS NetX/NetXDuo stack usage. It shows you how to develop a NetX UDP server to communicate with a remote client using the NetX UDP socket API.

This example demonstrates how an STM32H7 can be used to host CYW43xxx connectivity devices.

4.3.1 Hardware

Refer to the section on the STM32 hardware configuration descriptions as appropriate:

- [Using STM32H747 DISCO Kit](#)

4.3.2 Other software

Install a terminal emulator if you don't have one. Instructions in this document use [Tera Term](#).

Download [echotool](#) utility.

4.3.3 Project components

The following are the only components used in this project:

- Wifi/network-interface (configured as NetXDuo)
- Wifi/wifi-host-driver (WHD)
- Wifi/wcm
- Wifi/whd-bsp-integration
- Wifi/connectivity-utilities
- Bluetooth/btstack
- Bluetooth/btstack-integration
- Platform/pal (PAL, HAL, core-lib)
- Platform/abstraction-rtos (configured for the ThreadX kernel)
- Platform/device (configured as CYW43012)

4.3.4 Example project start/import

You can open this example by copying the example from the Pack to an appropriate location:

```
C:\Users\<USER>\STM32Cube\Repository\Packs\Infineon\Connectivity-STM32\1.3.0\Projects\STM32H747I-DISCO\Applications\wifi_netxduo
```

Once you have copied the example, you can then open it in STM32CubeMX and export to your IDE using the following steps from [Example project start/import](#). [Generate code](#), [Build the project](#) from [Wi-Fi Scan](#) example.

4.3.5 Project hardware setup

- Refer to section [Hardware Setup](#).

Using example projects

4.3.6 Operation

1. Connect the board to your PC using the provided USB cable through the ST-Link USB connector.
2. Modify the `WIFI_SSID` and `WIFI_PASSWORD` macros in `Application/User/NetXDuo/console_task.c` to match with those of the Wi-Fi network that you want to connect to.
3. Update the `DEFAULT_PORT` macro in `Application/User/NetXDuo/console_task.c`.
4. Open a terminal program and select the **ST-Link COM** port. Set the serial port parameters to 8N1 and 115200 baud.
5. Program the board using STM32CubeIDE or EWARM.

After programming, the application starts automatically. Observe the messages on the UART terminal, and wait for the device to make the required connections.

6. Run the [echotool](#) utility on a windows console as following:

```
# echotool.exe <board IP address> /p udp /r <DEFAULT_PORT> /n 10 /d "Hello World"
```

Example usage:

```
echotool.exe 192.168.1.2 /p udp /r 6000 /n 10 /d "Hello World"
```

4.4 Bluetooth® LE Hello Sensor

This code example demonstrates the implementation of a simple Bluetooth® Stack functionality in GAP Peripheral role. During initialization the app registers with LE stack to receive various notifications including bonding complete, connection status change and peer write. Peer device can also write in to client configuration descriptor of the notification characteristic.

4.4.1 Features demonstrated

- GATT database and Device configuration initialization
- Registration with LE stack for various events
- Sending data to the client
- Processing write requests from the client

4.4.2 Hardware

Refer to the section on the STM32 hardware configuration descriptions as appropriate:

- [Using STM32H747 DISCO Kit](#)

Using example projects

4.4.3 Other Software

This code example requires two devices: Host (Mobile Phone or PC) and a Target (STM32H747 DISCO Kit).

1. For the Host, download and install the AIROC™ Bluetooth® Connect App for iOS or Android. The AIROC™ Bluetooth® Connect App - iOS and Android versions are available for download on the [App Store](#) and [Google Play](#) store respectively.
2. Install a terminal emulator if you don't have one. Instructions in this document use [Tera Term](#).

4.4.4 Project Components

The following are the only components used in this project:

- Bluetooth/btstack
- Bluetooth/bluetooth-freertos
- Platform/pal
- Platform/abstraction-rtos (configured for the FreeRTOS kernel)
- Platform/device
- connectivity-utilities
- pal (minimum interface to ST HAL to enable connectivity)

4.4.5 Example Project Start/Import

You can open the Bluetooth® Hello Sensor example by copying the example from the Pack to an appropriate location:

```
C:\Users\<USER>\STM32Cube\Repository\Packs\Infineon\Connectivity-STM32\1.1.0\Projects\STM32H747I-DISCO\Applications\BLE_hello_sensor
```

Once you have copied the example, you can then open it in STM32CubeMX and export to your IDE using the following steps from section Example project start/ from Wi-Fi Scan example.

4.4.6 Project Hardware Setup

Refer to section [Hardware Setup](#).

4.4.7 Operation

1. Connect the STM32H747 DISCO Kit to your PC.
2. Use your favorite serial terminal application and connect to the ST-LINK (CN2) COM port. Configure the terminal application to access the serial port using the following settings.

Baud rate: 115200 bps; Data: 8 bits; Parity : None; Stop : 1 bit; Flow control : None; New line for receive data : Line Feed(LF) or Auto setting
3. Program the board.
4. After programming, the application starts automatically. Observe the messages on the UART terminal. Use the ST-LINK (CN2) COM port to view the Bluetooth® stack and application trace messages in the terminal window as shown below:

```
[0] Hello Sensor Start  
[0] wiced_bt_stack_init()
```

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```
[515] bt_post_reset_cback()
[515] bt_post_reset_cback(): Change baudrate (3000000) for FW downloading
[516] bt_update_controller_baudrate(): 3000000
[521] bt_baudrate_updated_cback(): Baudrate is updated for FW downloading
[522] bt_update_platform_baudrate(): 3000000
[722] bt_start_fw_download(): FW ver = [1428] bt_patch_download_complete_cback():
status=1
[1428] bt_fw_download_complete_cback(): Reset baudrate to 115200
[1429] bt_update_platform_baudrate(): 115200
[1630] bt_fw_download_complete_cback(): Changing baudrate to 3000000
[1630] bt_update_controller_baudrate(): 3000000
[2065] bt_baudrate_updated_cback(): Baudrate is updated for feature
```

5. To test using the mobile app, do the following:

- a. Turn ON Bluetooth® on your Android or iOS device.
- b. Launch the app on your Phone.
- c. Swipe down on the app home screen to start scanning for Bluetooth® LE Peripherals; your device ("hello") appears in the app home screen. Select your device to establish a Bluetooth® LE connection.



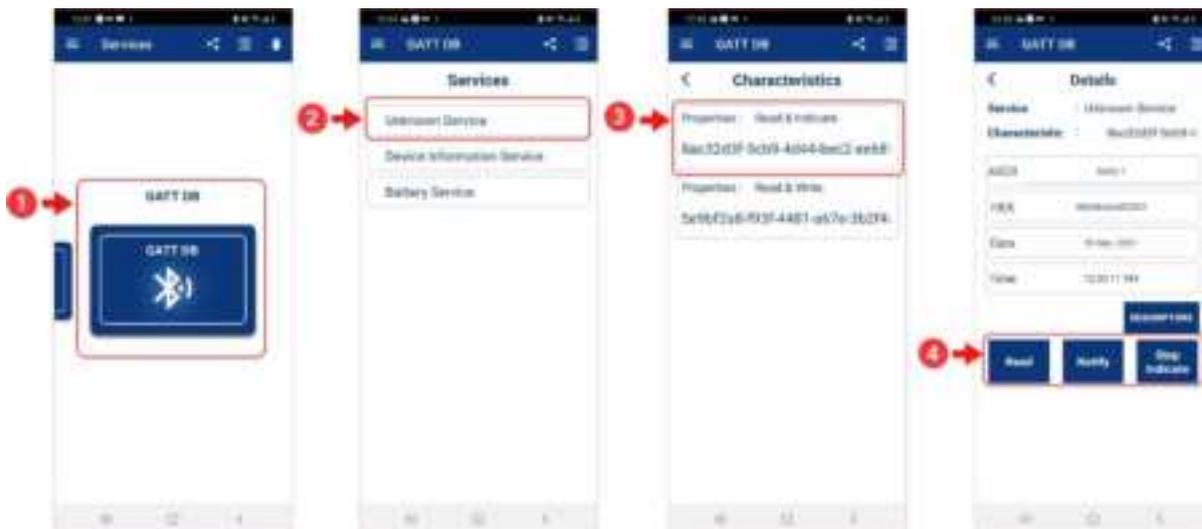
d. Read Battery.

- Select the 'Battery' Profile from the carousel view.
- Press Read button.



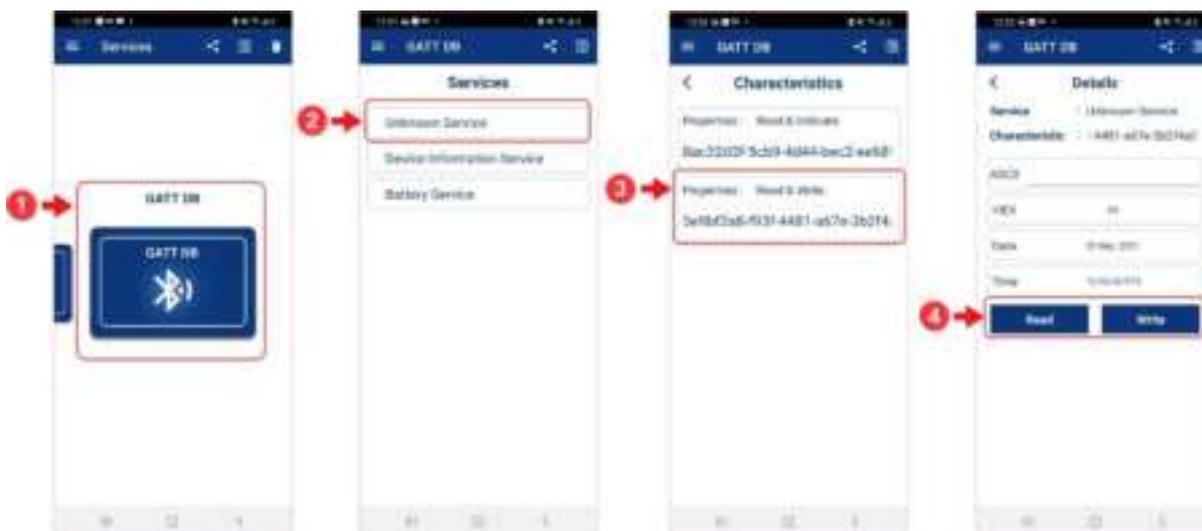
Using example projects

e. Enable Sensor notification/indication as shown in the following images.



The notification "Hello N" appears every 10 seconds.

f. Read / Write the Sensor characteristic.



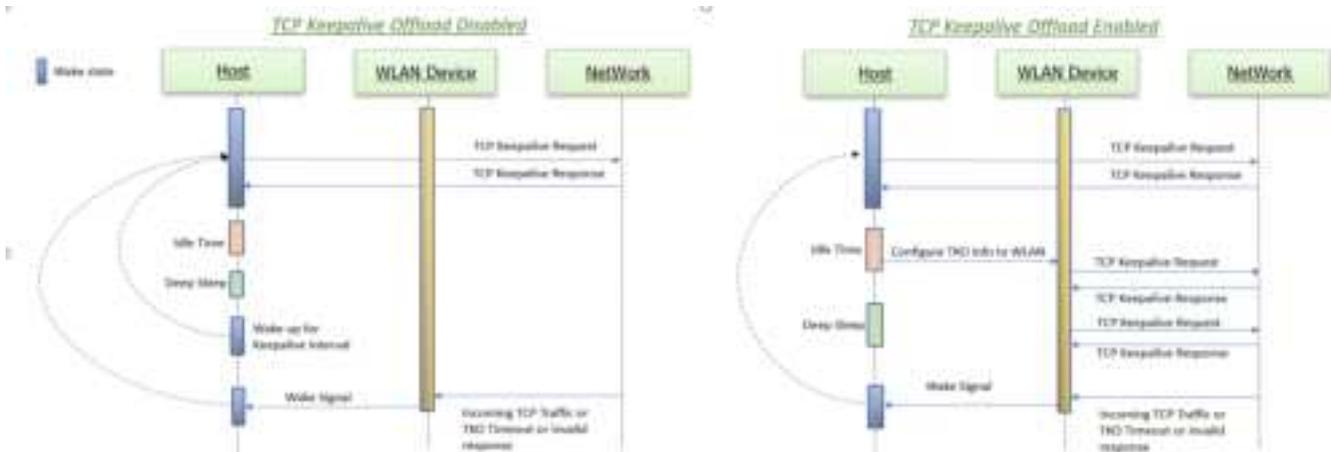
4.5 Wi-Fi TCP keepalive offload

The TCP keepalive offload feature of the Low Power Assistant (LPA) improves the power consumption of your connected system by reducing the time the Host needs to stay awake to support a TCP keepalive request. This example describes how to enable TCP keepalive offload and configure four different sockets for TCP keepalive that can be incorporated into your project from LPA Middleware.

TCP keepalive maintains idle TCP connections by periodically passing packets between the client and server. If either the client or server does not respond to a packet, the connection is considered inactive and is terminated. This helps in pruning dead connections. Typically, TCP keepalives are sent every 45 or 60 seconds on an idle TCP connection, and the connection is dropped after 3 sequential ACKs are missed. This means the Host MCU has to wake up periodically to send a TCP keepalive packet to maintain TCP connection during idle state.

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TCP keepalive offload helps in moving this functionality to WLAN firmware so that the Host MCU does not need to wake up periodically to send/receive TCP keepalive packets. This functionality is offloaded only when the Host MCU goes to sleep and network stack is suspended.



4.5.1 Hardware

Refer to section the STM32 hardware configuration descriptions as appropriate:

- [Using STM32H747 DISCO Kit](#)

4.5.2 Other software

Install a terminal emulator if you don't have one. Instructions in this document use [Tera Term](#).

4.5.3 Project components

The following are the components used in this project:

- Wifi/network-interface (configured as LWIP)
- Wifi/wifi-host-driver (WHD)
- Wifi/wcm
- Wifi/whd-bsp-integration
- Wifi/connectivity-utilities
- Wifi/secure-sockets
- Wifi/LwIP
- Wifi/mbedtls
- Wifi/lpa
- Platform/pal (PAL, HAL, core-lib)
- Platform/abstraction-rtos (configured for the FreeRTOS kernel)
- Platform/device (configured as CYW43012)
- Platform/module (configured as MURATA-1V)

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4.5.4 Example project start/import

You can open the Wi-Fi Onboarding with Bluetooth® LE example by copying the example from the Pack to an appropriate location:

```
C:\Users\<USER>\STM32Cube\Repository\Packs\Infineon\Connectivity-STM32\1.4.0\Projects\
STM32H747I-DISCO\Applications\wifi_tko
```

Once you have copied the example, you can then open it in STM32CubeMX and export to your IDE using the following steps from Example project start/import. Generate code, Build the project_ from Wi-Fi Scan example.

4.5.5 Project hardware setup

Refer to section [Hardware Setup](#).

4.5.6 Operation

1. Connect the STM32H747 DISCO Kit to your PC.
2. Open **app_config.h** and modify the **WIFI_SSID**, **WIFI_PASSWORD**, and **WIFI_SECURITY_TYPE** macros to match the Wi-Fi network credentials that you want to connect to. All possible security types are defined in the `cy_wcm_security_t` structure in `cy_wcm.h` file.
3. Ensure that your computer is connected to the same Wi-Fi access point (AP) that you configured in Step 2 and Setup a TCP server and the server starts listening for incoming TCP connections.
4. Open a **cycfg_connectivity_wifi.c** and modify `cy_tko_ol_cfg_0`, ports, **remote_port** and **remote_ip** to match the TCP server that be set up on your computer;
5. Use your favorite serial terminal application and connect to the ST-LINK (CN2) COM port. Configure the terminal application to access the serial port using the following settings.

Baud rate: 115200 bps

Data: 8 bits

Parity: None

Stop: 1 bit

Flow control: None

New line for receive data: Line Feed (LF) or Auto setting

6. Program the board.

Note: For dual-core MCUs (e.g STM32H7), the both cores must be programmed.

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7. After programming, the application starts automatically. Observe the messages on the UART terminal, and wait for the device to make all the required connections. application trace messages in the terminal window as shown below:

```
WLAN MAC Address : 00:A0:50:45:13:81
WLAN Firmware   : wl0: Apr 12 2022 20:39:36 version 13.10.271.287 (760d561 CY) FWID 01-b438e2a0
WLAN CLM       : API: 18.2 Data: 9.10.0 Compiler: 1.36.1 ClmImport: 1.34.1 Creation: 2021-04-26
04:01:15
WHD VERSION     : v2.4.0 : v2.4.0 : GCC 10.3 : 2022-08-04 17:12:02 +0800
Info: Wi-Fi initialization is successful
Info: Join to AP: SM9500
Info: Successfully joined wifi network SM9500
Info: Assigned IP address: 192.168.43.124
Info: Taking TCP Keepalive configuration from the Generated sources.
Info: Socket[0]: Created connection to IP 192.168.43.228, local port 3353, remote port 3360
Info: Skipped TCP socket connection for socket id[1]. Check the TCP Keepalive configuration.
Info: Skipped TCP socket connection for socket id[2]. Check the TCP Keepalive configuration.
Info: Skipped TCP socket connection for socket id[3]. Check the TCP Keepalive configuration.
whd_tko_toggle: Successfully enabled

Network Stack Suspended, MCU will enter DeepSleep power mode
Resuming Network Stack, Network stack was suspended for 31867ms

=====
WHD Stats..
tx_total:73, rx_total:74, tx_no_mem:0, rx_no_mem:0
tx_fail:0, no_credit:0, flow_control:0
Bus Stats..
cmd52:2430, cmd53_read:393, cmd53_write:596
cmd52_fail:7, cmd53_read_fail:0, cmd53_write_fail:0
oob_intrs:0, sdio_intrs:484, error_intrs:0, read_aborts:0
=====
Network is active. Resuming network stack
whd_tko_toggle: Successfully disabled
whd_tko_toggle: Successfully enabled

Network Stack Suspended, MCU will enter DeepSleep power mode
Resuming Network Stack, Network stack was suspended for 4142ms
```

Manufacture tools

5 Manufacture tools

The following manufacture tool projects are included in the pack:

- [Tester - Wi-Fi Bluetooth® Console](#)
- [WLAN manufacturing test application \(Wifi-Mfg-Tester\) for FreeRTOS](#)
- [Bluetooth® Manufacturing Test Application for FreeRTOS](#)

5.1 Tester - Wi-Fi Bluetooth® Console

This application integrates the command console library including Wi-Fi iPerf and Bluetooth® Low Energy functionality. You can use this application to characterize the Wi-Fi/Bluetooth® LE functionality and performance.

This example demonstrates how an STM32H7 can be used to host CYW43xxx connectivity devices.

5.1.1 Hardware

Refer to the section on the STM32 hardware configuration descriptions as appropriate:

- [Using STM32H747 DISCO Kit](#)

5.1.2 Other software

Install a terminal emulator if you don't have one. Instructions in this document use [Tera Term](#).

Setting up iPerf on the host:

- [iPerf 2.0.13](#) (supported on Ubuntu, macOS, and Windows)
- Go to the iPerf installation directory and launch the terminal (command prompt for Windows, terminal shell for macOS or Ubuntu).

5.1.3 Project components

The following are the only components used in this project:

- Wifi/network-interface (configured as LWIP)
- Wifi/wifi-host-driver (WHD)
- Wifi/wcm
- Wifi/whd-bsp-integration
- Wifi/connectivity-utilities
- Wifi/secure-sockets
- Wifi/LwIP
- Bluetooth/btstack
- Bluetooth/btstack-integration
- Platform/pal (PAL, HAL, core-lib)
- Platform/abstraction-rtos (configured for the FreeRTOS kernel)
- Platform/device (configured as CYW43012)
- MfgTools/command-console

Manufacture tools

5.1.4 Example project start/import

You can open this example by copying the example from the Pack to an appropriate location:

```
C:\Users\<USER>\STM32Cube\Repository\Packs\Infineon\Connectivity-STM32\1.3.0\Projects\STM32H747I-DISCO\Applications\wifi_bt_tester
```

Once you have copied the example, you can then open it in STM32CubeMX and export to your IDE using the following steps from Example project start/import. Generate code, Build the project from Wi-Fi Scan example.

5.1.5 Project hardware setup

Refer to section [Hardware Setup](#).

5.1.6 Operation

1. Connect the board to your PC using the provided USB cable through the ST-Link USB connector.
2. Modify the **WIFI_SSID** and **WIFI_KEY** macros in *Application/User/Core/console_task.c* to match with those of the Wi-Fi network that you want to connect to.
3. To join a Wi-Fi network of a specific band, update the **WIFI_BAND** macro in *Application/User/Core/console_task.c* as follows:
CY_WCM_WIFI_BAND_2_4GHZ: 2.4-GHz band **CY_WCM_WIFI_BAND_5GHZ**: 5-GHz band
4. Configure the TCP window size in iPerf before building the application. See the command console library's [README.md](#) for instructions on how to configure the TCP window size.
5. Open a terminal program and select the ST-Link COM port. Set the serial port parameters to 8N1 and 115200 baud.
6. Program the board using STM32CubeIDE or EWARM. After programming, the application starts automatically. Observe the messages on the UART terminal, and wait for the device to make the required connections.
7. The application connects to the configured Wi-Fi access point (AP) and obtains the IP address. When the device is ready, the > prompt appears.
8. Run iPerf commands (client and server) against a remote peer device.
 - See [Running iPerf client and server against a remote peer device](#).
9. Run Bluetooth® LE commands against a remote peer device.

Manufacture tools

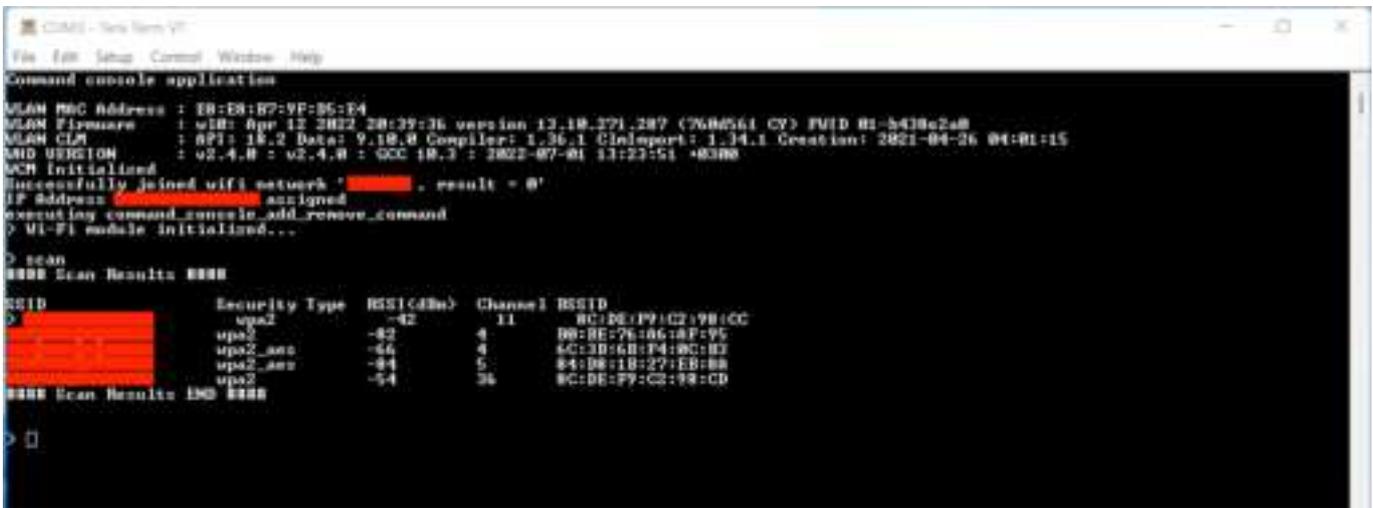
5.1.7 Serial terminal setup

The terminal interface is a virtual COM port which is part of the ST-LINK (CN2) USB connection.

Terminal emulator configuration:

- Baud Rate: 115200
- Data Length: 8 Bits
- Stop Bit(s): 1
- Parity: None
- Flow control: None

5.1.8 Example output

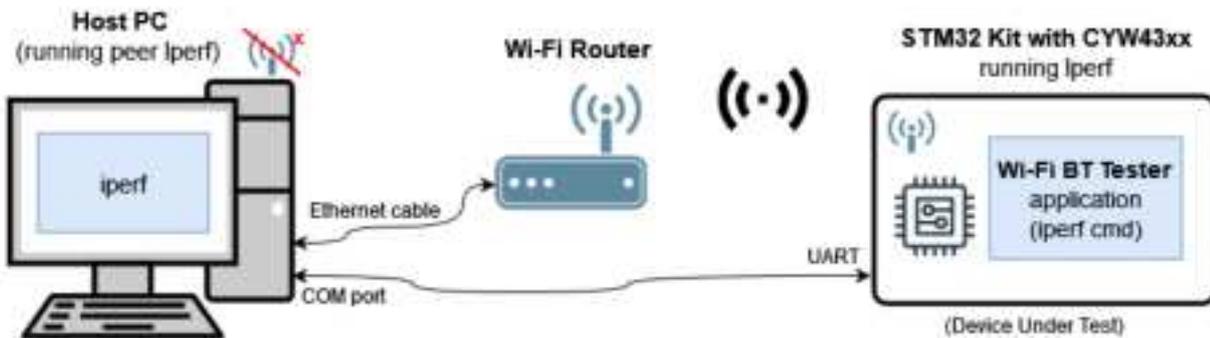


5.1.9 iPerf measurement

iPerf commands are used for measuring the Wi-Fi performance/throughput. The iperf tool sends TCP/UDP data between two peer devices to compute the Wi-Fi performance/throughput.

5.1.9.1 iPerf setup

The following diagram shows the exact setup that should be used for measuring the Wi-Fi performance/throughput of a STM32 device using iperf.



Manufacture tools**5.1.9.2 iPerf commands for Wi-Fi throughput measurement**

Enter the following commands on the STM32 device (DUT) after the device boots up and connects to the Wi-Fi network. This section provides only the commands to be run on the DUT. When the 'client *iperf* command' runs on the DUT, the 'server *iperf* command' should run on the host PC (as shown in the iPerf Setup diagram), and vice versa.

1. Start iPerf as a TCP server:

```
iperf -s
```

Note: On the peer iPerf device (host PC), start iPerf as a TCP client to send the TCP data.

2. Start iPerf as a TCP client:

```
iperf -c <server_ip_addr> -t <time in sec>
```

Sample command:

```
iperf -c 192.168.0.100 -t 60
```

Note: On the peer iPerf device (host PC), start iPerf as a TCP server.

3. Start iPerf as a UDP server:

```
iperf -s -u
```

Note: On the peer iPerf device (host PC), start iPerf as a UDP client to send the UDP data.

4. Start iPerf as a UDP client:

```
iperf -c <server_ip_addr> -t <time in sec> -u -b <band width>
```

Sample command:

```
iperf -c 192.168.0.100 -t 60 -u -b 50M
```

Note: On the peer iPerf device (host PC), start iPerf as a UDP server.

Manufacture tools

5.1.9.3 Results

STM32H747 DISCO + CYW43012

TCP/ UDP	Throughput, Mbit/s		Command
	2.4G	5G	
TCP TX	35.3	42.7	iperf -c <ip> -t 60
TCP RX	35.7	39.2	iperf -s
UDP TX	52.4	52.4	iperf -c <ip> -t 60 -u -b 50M
UDP RX	50.0	50.0	iperf -s -u

Test configuration: Iperf app run on STM32H747 CM7/400Mhz, GCC, Wi-Fi router: Asus RT-AX56U.

STM32L5-DK + CYW43012

TCP/ UPD	Throughput, Mbit/s		Command
	2.4G	5G	
TCP TX	20.2	20.5	iperf -c <ip> -t 60
TCP RX	20.6	20.8	iperf -s
UDP TX	31.0	31.1	iperf -c <ip> -t 60 -u -b 50M
UDP RX	25.7	24.7	iperf -s -u

Test configuration: Iperf app run on STM32L5 CM33/110Mhz, GCC, Wi-Fi router: Asus RT-AX56U.

STM32U575I-EV + CYW43012

TCP/ UPD	Throughput, Mbit/s		Command
	2.4G	5G	
TCP TX	26.5	27.4	iperf -c <ip> -t 60
TCP RX	25.3	26.1	iperf -s
UDP TX	36.5	36.6	iperf -c <ip> -t 60 -u -b 50M
UDP RX	33.8	33.9	iperf -s -u

Test configuration: Iperf app run on STM32U5 CM33/160Mhz, GCC, Wi-Fi router: Asus RT-AX56U.

5.2 WLAN manufacturing test application (Wifi-Mfg-Tester) for FreeRTOS

The Wifi-Mfg-Tester is used to validate the WLAN firmware and radio performance of Wi-Fi chips.

The Wifi-Mfg-Tester acts as a transport layer between the host "wl tool" and the WLAN firmware, and receives the commands from the wl tool and forwards them to the WLAN firmware using IOVAR/IOCTL commands. It also relays the response received back from the WLAN firmware.

The wl tool binaries for testing the WLAN firmware are also included in this application repository.

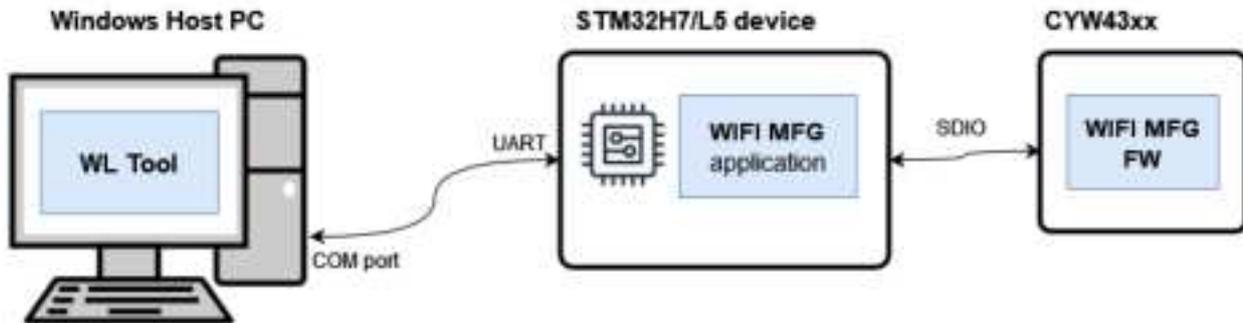
This example demonstrates how an STM32H7 can be used to host CYW43xxx connectivity devices.

5.2.1 Hardware

Refer to the section on the STM32 hardware configuration descriptions as appropriate: [Using STM32H747 DISCO Kit](#)

Manufacture tools

Test setup are shown below:



5.2.2 Other software

Install a terminal emulator if you don't have one. Instructions in this document use [Tera Term](#).

This application requires the WL tool running on a Windows PC. The pre-built executables for the WL tool are available in the *wl-tool-bin*.

5.2.3 Project components

The following list shows the only components used in this project:

- Wifi/wcm
- Wifi/wifi-mw-core
- Wifi/wifi-host-driver (WHD)
- Wifi/whd-bsp-integration
- Wifi/connectivity-utilities
- Wifi/LwIP
- Platform/pal (PAL, HAL, core-lib)
- Platform/abstraction-rtos (configured for the FreeRTOS kernel)
- Platform/device
- MfgTools/wifi-mfg-test

5.2.4 Example project start/import

You can open the example by copying this example from the Pack to an appropriate location:

```
C:\Users\<USER>\STM32Cube\Repository\Packs\Infineon\Connectivity-STM32\1.1.0\Projects\
STM32H747I-DISCO\Applications\wifi_mfg_tester
```

Once you have copied the example, you can then open it in STM32CubeMX and export to your IDE using the following steps from Example project start/import. Generate code, Build the project from Wi-Fi Scan example.

5.2.5 Project hardware setup

Refer to section [Hardware Setup](#).

5.2.6 Operation

1. Go to the WL tool directory:

Manufacture tools

```
# cd wl-tool-bin
```

2. Reset the board by pressing the Reset button.
3. Run the command on Windows host for the WLAN chip on the target board:

```
wl43012C0.exe --serial <port> ver
```

For example:

```
#wl43012C0.exe --serial 5 ver
cmd resp: 7/19/2017 build 0
wl0: Jan 11 2022 21:32:24 version 13.10.271.280 (c32ff79 CY WLTEST) FWID 01-
3566e923
```

4. Observe the output of the command.

The list of WL commands which can be retrieved by typing `--help`. Partial output of the command and display is as follows:

```
# wl43012C0.exe --serial 5 -help
```

```
Usage: wl43012C0.exe [-a|i <adapter>] [-h] [-d|u|x] <command> [arguments]
```

```
-h          this message and command descriptions
-h [cmd]    command description for cmd
-a, -i      adapter name or number
-d          output format signed integer
-u          output format unsigned integer
-x          output format hexadecimal
ver         get version information
cmds       generate a short list of available commands
```

```
ioctl_echo check ioctl functionality
up          reinitialize and mark adapter up (operational)
down       reset and mark adapter down (disabled)
out        mark adapter down but do not reset hardware(disabled)
           On dual-band cards, cards must be band-locked before use.
```

Manufacture tools

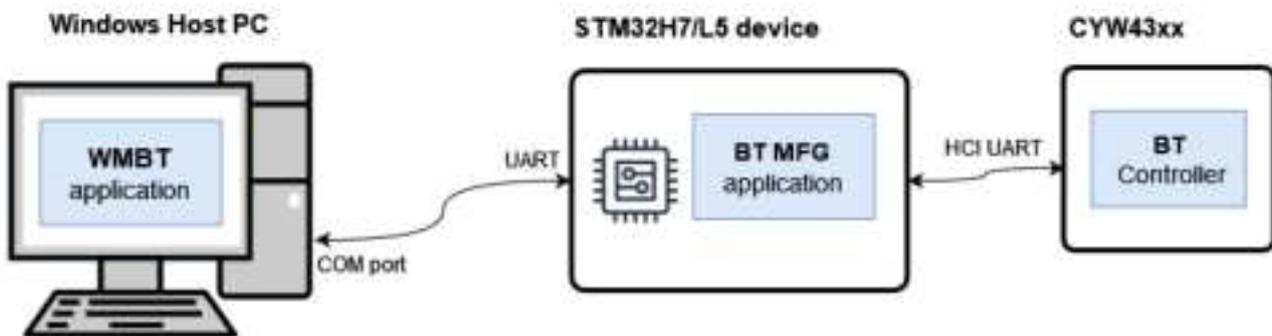
5.3 Bluetooth® Manufacturing Test Application for FreeRTOS

The Bluetooth® Manufacturing Test Application is used to validate the Bluetooth® Firmware and RF performance of Cypress SoC Bluetooth® BR/EDR/LE devices.

The Bluetooth® MFG Application acts as a transport layer between the host "WMBT tool" and Bluetooth® Firmware. Mfg Test Application receive commands from the WMBT tool and forwards them to the Bluetooth® firmware. The Bluetooth® MFG Application also relays the response received back from Bluetooth® firmware.

This example demonstrates how an STM32H7 can be used to host CYW43xxx connectivity devices.

Test setup are shown below:



5.3.1 Hardware

Refer to the section on the STM32 hardware configuration descriptions as appropriate:

- [Using STM32H747 DISCO Kit](#)

5.3.2 Other software

- This application requires the WMBT Tool running on a windows PC and uses a UART port for communication with the target. The pre-built executables for the WMBT Tool are available in *bt_mfg_tester/wmbt-tool-bin* directory, which sync from [btsdk-utils](#). The user guide is in [Bluetooth® Manufacturing Test Tool](#).
- Use the IQxel tool as a transmitter to send a fixed count test packet to ensure whatever is sent from the transmitter is received without any error.
- Use a Sniffer to ensure that whatever is included in the test packet is in same transmit channel, packet length and data patterns from the transmitter. Better to test it in the shield room to avoid air interference

5.3.3 Project components

The following are the only components used in this project:

- Bluetooth/btstack
- Bluetooth/btstack-integration
- Platform/pal (PAL, HAL, core-lib)
- Platform/abstraction-rtos (configured for the FreeRTOS kernel)
- Platform/device (configured as CYW43012)

Manufacture tools

5.3.4 Example project start/import

You can open the example by copying this example from the Pack to an appropriate location:

```
C:\Users\<USER>\STM32Cube\Repository\Packs\Infineon\Connectivity-STM32\1.3.0\Projects\
STM32H747I-DISCO\Applications\bt_mfg_tester
```

Once you have copied the example, you can then open it in STM32CubeMX and export to your IDE using the following steps from Example project start/import. Generate code, Build the project from Wi-Fi Scan example.

5.3.5 Project hardware setup

Refer to section [Hardware Setup](#).

5.3.6 Operation

1. Go to WMBT tool directory
2. Reset the Board by pressing Reset button
3. Run the command on Windows Host for the proper BT Chip on target board.
4. Observe the output of the command

List of wmbt commands with Bluetooth® LE function which can be retrieved by typing --help Partial output of the command and display is below.

```
wmbt reset COMx
```

5.3.6.1 Example output

```
# wmbt.exe reset COM5

cmd resp: MBT_BAUD_RATE: 115200
TRANSPORT_MODE: 0 (HCI)

Opened COM5 at speed: 115200
Close Serial Bus
Opened COM5 at speed: 115200

Sending HCI Command:
0000 < 01 03 0C 00 >

Received HCI Event:
0000 < 04 0E 04 01 03 0C 00 >

Success
Close Serial Bus
```

Special options and setup

6 Special options and setup

6.1 STM32H7xx – using serial flash

There may be a need for extra internal Flash space when running applications on STM32H7xx. A significant amount of internal Flash can be saved if the Wi-Fi stack is placed on an external Serial Flash memory module. The STM32H747I-DISCO board has MT25QL512ABB8ESF-0SIT memory IC present for this purpose.

- STM32H747I-DISCO has serial Flash in dual-bank Quad-SPI mode
- STM32H7 has QSPI HW block

Additional settings are needed to enable placing the Wi-Fi stack firmware on external memory:

1. Linker script (*.ld) has external memory address defined:

```
QSPI (rx) : ORIGIN = 0x90000000, LENGTH = 131072K
```

2. Linker script has section name defined where Wi-Fi stack will be located during linkage:

```
.whd_fw :
{
  __whd_fw_start = .;
  KEEP(*(.whd_fw))
  __whd_fw_end = .;
} > OSPI
```

3. Preprocessor macro name added:

```
CY_STORAGE_WIFI_DATA=".whd_fw"

BSP-files have to be added:
BSP\stm32h747i_discovery_qspi.c
BSP\stm32h747i_discovery_qspi.h
BSP\Components\mt25tl01g\mt25tl01g.c(*.h)
BSP\Components\mt25tl01g\mt25tl01g.c(*.h)
BSP\Components\mt25tl01g\mt25tl01g_conf.h
```

4. BSP Initialization routine call have to be added:

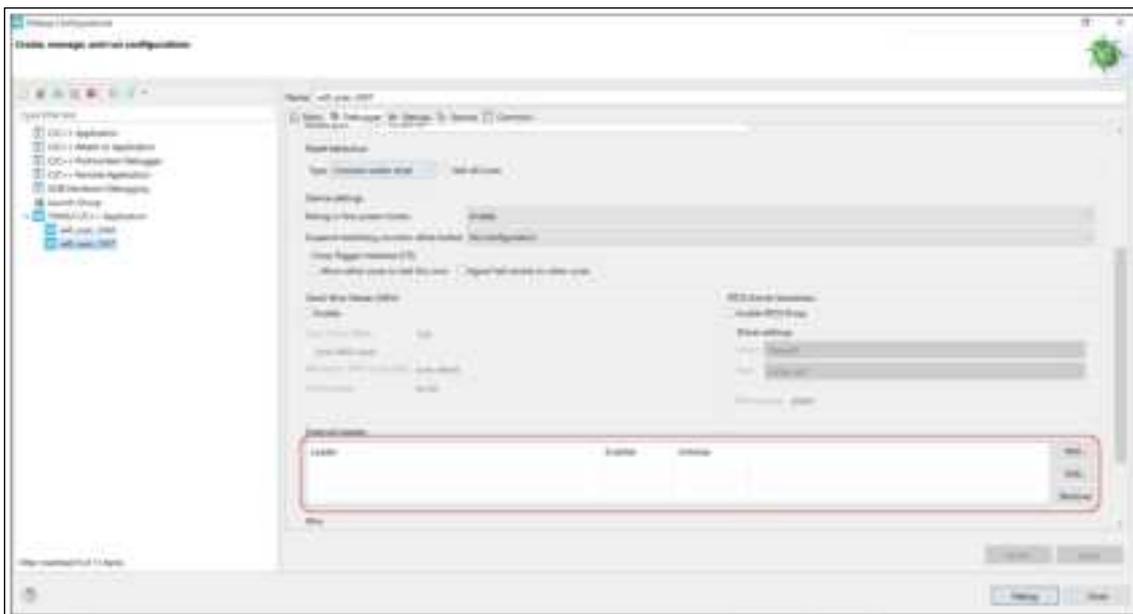
```
/* Configure External Memory to Memory Mapped Mode*/
/* QSPI info structure */
BSP_QSPI_Info_t pQSPI_Info;
uint8_t status;
/*##-1- Configure the QSPI device #####*/
/* QSPI device configuration */
BSP_QSPI_Init_t init ;
init.InterfaceMode=MT25TL01G_QPI_MODE;
init.TransferRate= MT25TL01G_DTR_TRANSFER ;
init.DualFlashMode= MT25TL01G_DUALFLASH_ENABLE;
status = BSP_QSPI_Init(0,&init);
if (status != BSP_ERROR_NONE)
{
    printf("\r\n ERROR: BSP_QSPI_Init() failed \r\n");
    Error_Handler();
}
/*##-2- Read & check the QSPI info #####*/
/* Initialize the structure */
pQSPI_Info.FlashSize = (uint32_t)0x00;
pQSPI_Info.EraseSectorSize = (uint32_t)0x00;
pQSPI_Info.EraseSectorsNumber = (uint32_t)0x00;
pQSPI_Info.ProgPageSize = (uint32_t)0x00;
```

Special options and setup

```

pQSPI_Info.ProgPagesNumber    = (uint32_t)0x00;
/* Read the QSPI memory info */
BSP_QSPI_GetInfo(0, &pQSPI_Info);
/*##-6-Memory Mapped Mode #####*/
status = BSP_QSPI_EnableMemoryMappedMode(0);
if (status != BSP_ERROR_NONE)
{
    printf("\r\n    ERROR: BSP_QSPI_EnableMemoryMappedMode() failed \r\n");
    Error_Handler();
}
    
```

5. Programming of the Serial Flash should be performed with appropriate Flash Loader selection:



Note: External flash (MT25QL512ABB8ESF) requires 3.3 V for normal operation.

6.2 STM32H7xx – using internal flash (BANK2) to store Wi-Fi FW

The internal flash space on STM32H7xx is divided into two banks: BANK1 (1M) is used for CM7, BANK2 (1M) is used for CM4. The steps to reuse part of BANK2 to store Wi-Fi firmware images:

1. Update the linker script (*.ld):

a. Add WIFI_FLASH memory definition to the MEMORY section of the linker script:

```

WIFI_FLASH (rx) : ORIGIN = 0x08140000, LENGTH = 768K /* ORIGIN address of
BANK2 (0x08100000) with 768K offset */
    
```

Special options and setup

- b. Define the whd_fw section where the Wi-Fi FW will be located during linkage:

```
.whd_fw :
{
  __whd_fw_start = .;
  KEEP(*(.whd_fw))
  __whd_fw_end = .;
} >WIFI_FLASH
```

2. Add the reprocessor macro name:

```
CY_STORAGE_WIFI_DATA=".whd_fw"
```

6.3 STM32L562 – using serial flash

The Wi-Fi application can't fit STM32L5x internal flash due to size constraints. MCU has 512kB of area when connectivity firmware reaches over 1MB.

To resolve this external memory module is used, present on STM32L562E-DK board.

The project has the following additional settings made to enable placing WiFi stack firmware on external memory:

1. Linker script (*.ld) has external memory address defined:

```
OSPI(rx) : ORIGIN = 0x90000000, LENGTH = 65536K
```

2. Linker script has section name defined where WiFi stack will be located during linkage:

```
.whd_fw :
{
  __whd_fw_start = .;
  KEEP(*(.whd_fw))
  __whd_fw_end = .;
} > OSPI
```

3. Preprocessor macro name added:

```
CY_STORAGE_WIFI_DATA=".whd_fw"
```

With given setup, the compiler and linker will split a resulting image into two pieces, which will reside in both – internal and external memory of an STM32L562E-DK.

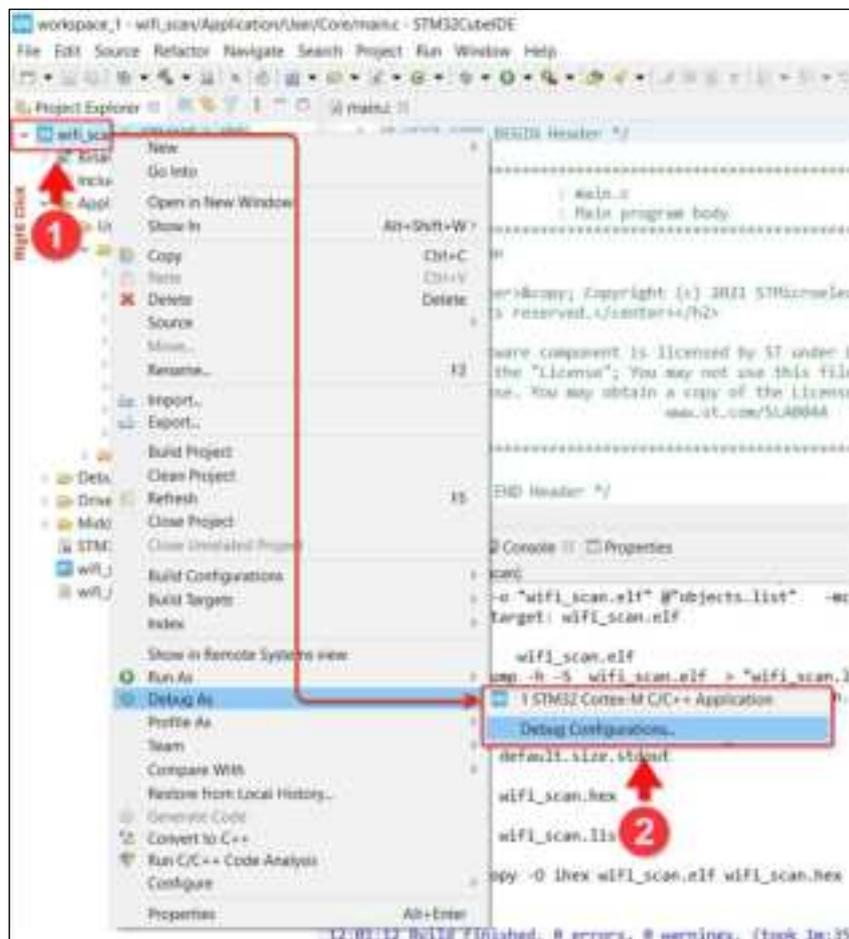
Special options and setup

6.4 STM32L562 – serial flash programming

6.4.1 Using STM32CubeMX IDE

To program resulting image into the target device an appropriate Flash loader has to be selected:

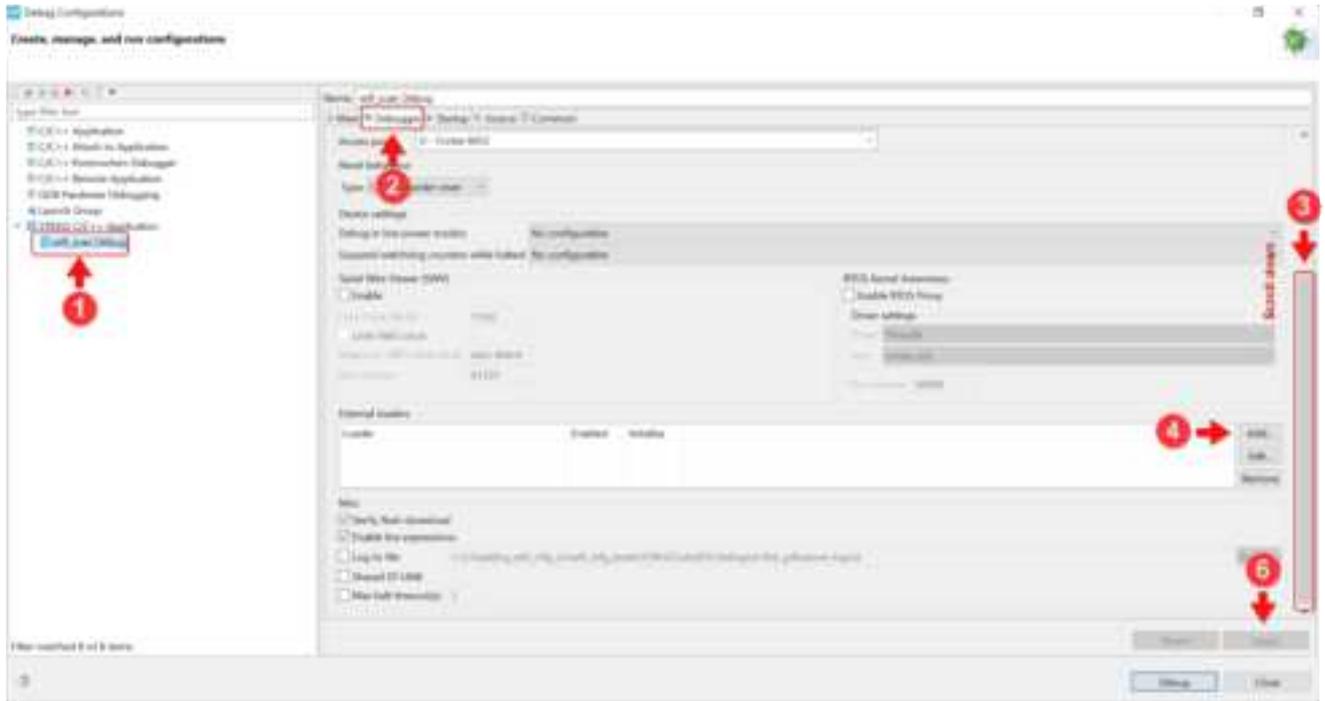
Right-click on a project, select **Debug As > Debug Configurations...**



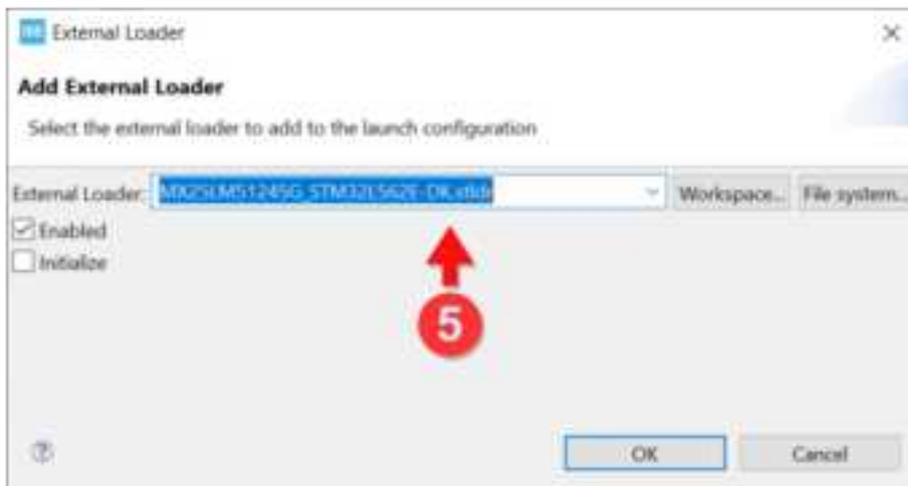
Special options and setup

Select the external loader (see steps illustrated in the following image).

- Select "wifi_scan Debug" and select the **Debugger** tab.
- Scroll down and find the **External Loader**.
- Click **Add** button to add external loader.



- Enter the appropriate loader in the External loader dialog:
MX25LM51245G_STM32L562E-DK.stldr



Program your target with "Run" or "Debug" command.

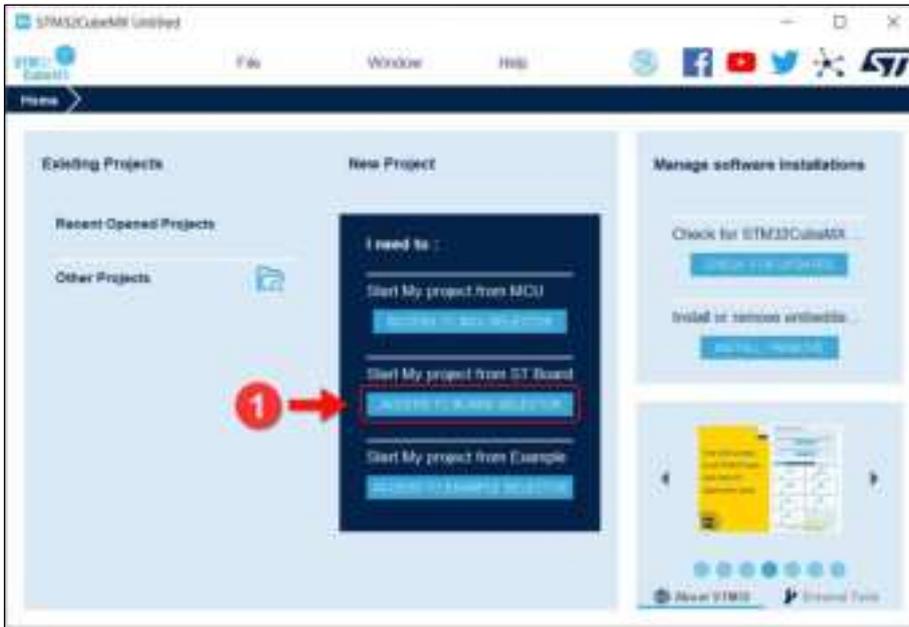
Create a new project from scratch

7 Create a new project from scratch

This section takes you step-by-step through the process of creating a project file from scratch.

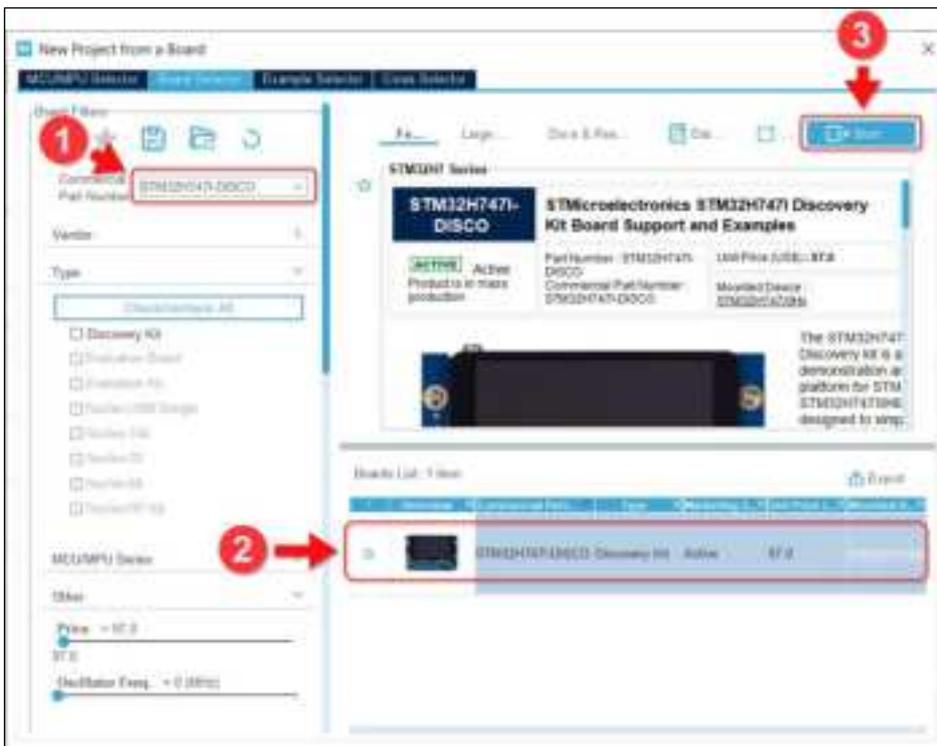
7.1 Create a project for specific board

1. Start creating a project via the **ACCESS TO BOARD SELECTOR** option.



2. Select a board.

- Enter/select the board number.
- Click on your selected board.
- Select Start Project.

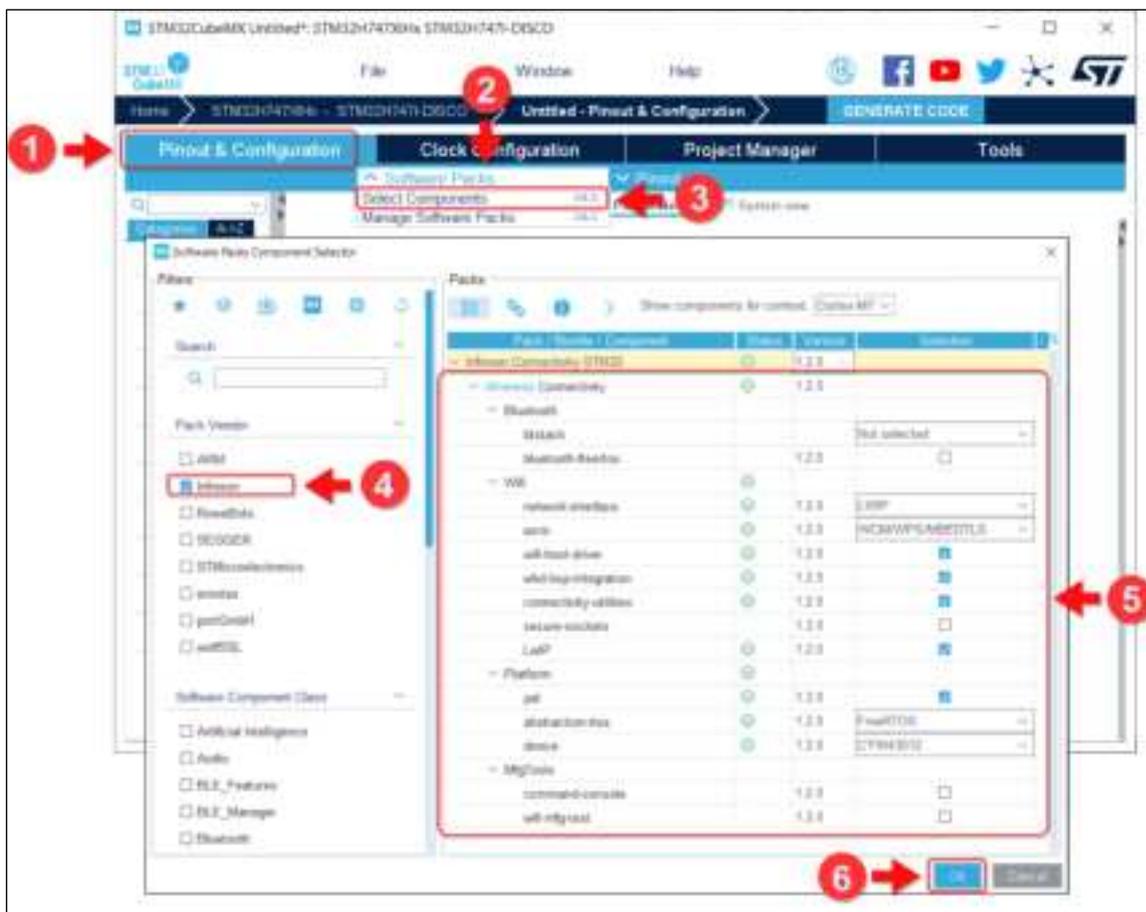


Create a new project from scratch

7.2 Enable software components from STM32 connectivity expansion pack

1. Select the **Pinout & Configuration** tab.
2. Select **Software Packs**.
3. Select **Select Components**

This will open the Software Packs Component Selector dialog with a list of the installed packs and their contents.



4. Select Infineon under **Pack Vendor**.
5. Select the components you need for your project.

All projects will use three ‘Platform’ components. If you are using Wi-Fi, select all the ‘Wifi’ components. If you are using Bluetooth® LE, select all ‘Bluetooth’ components.

Note: Platform components are required for each type of application – either Wi-Fi-only, Bluetooth-only or combined.

- c. For the ‘Platform / device’ component, select the appropriate connectivity device for your system (CYW43012, CYW4343W or CYW43438, etc.).
- d. For the ‘Wifi / network-interface’ component, select the appropriate network interface for your system (LwIP or NetxDuo).

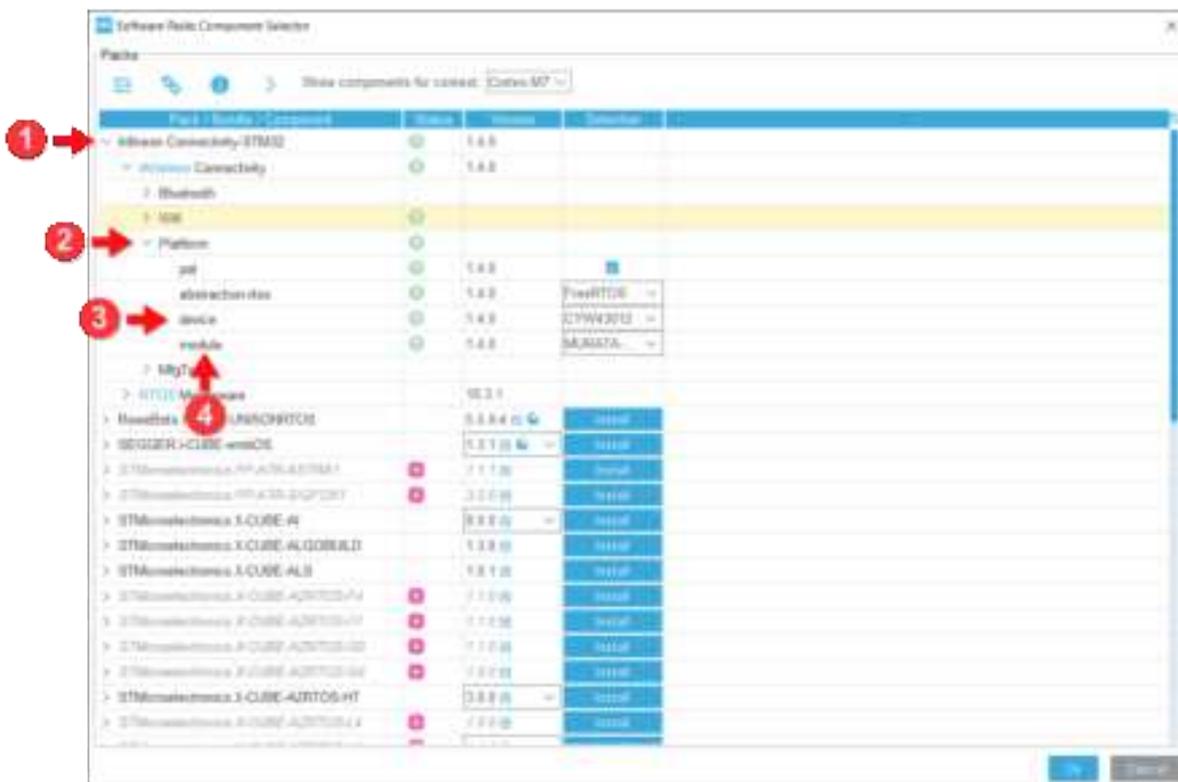
Create a new project from scratch

- e. For the 'Wifi / wcm' component, select the appropriate variant (WCM or WCM /WPS/MBEDTLS).
 - WCM Variant compiles only Wi-Fi connection manager files, which provide a set of APIs that can be used to establish and monitor Wi-Fi connections on Infineon platforms that support Wi-Fi connectivity.
 - WCM /WPS/MBEDTLS Variant also includes APIs to connect to a Wi-Fi network using Wi-Fi Protected Setup (WPS) methods which uses MBED TLS security stack.

6. Click **OK**.

7.2.1 Module selection

The STM32 connectivity expansion pack has a software component named wifi-nwram-configuration (in the "Platform" section), which is used to select the NVRAM configuration for the Connectivity module. Also, you can select the USER_NVRAM variant for custom configuration. To do this, provide own your NVRAM header somewhere in your project (for example, in the "Core/Inc" folder).



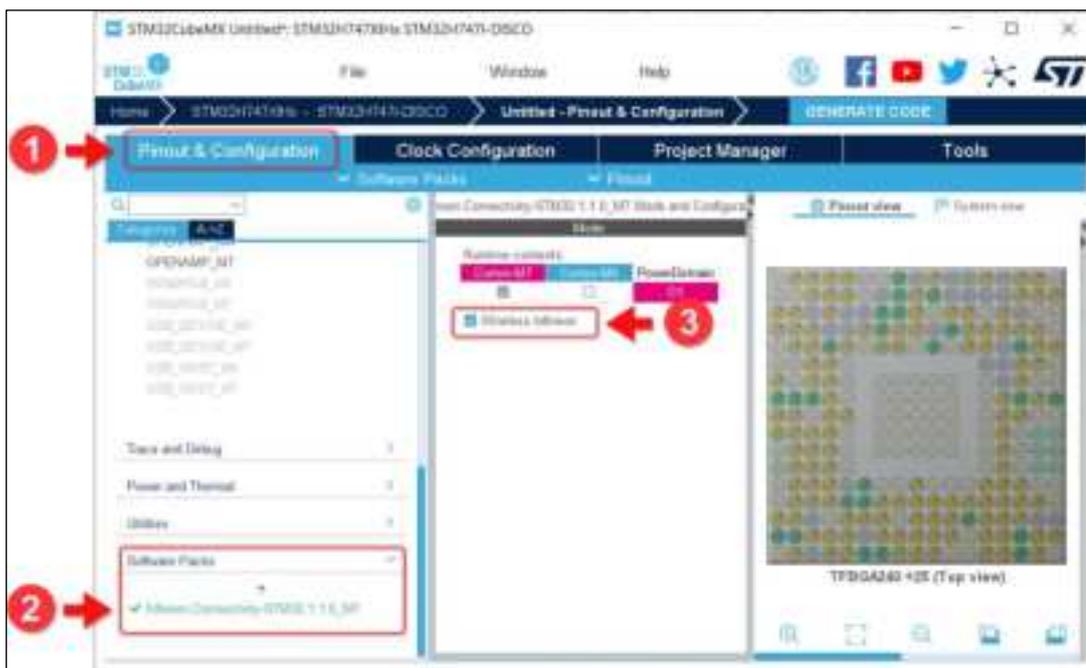
Module	Device	Description
MURATA-1LV	CYW43012	Type 1LV is a small and high-performance module based on Infineon CYW43012 combo chipset which supports Wi-Fi® 802.11a/b/g/n + Bluetooth® 5.0 BR/EDR/LE up to 72.2Mbps PHY data rate on Wi-fi® and 3Mbps PHY data rate on Bluetooth®. 2Mbps LE PHY is also supported. The WLAN section supports SDIO v2.0 SDR25 interface and the Bluetooth® section supports high-speed 4-wire UART interface and PCM for audio data.
MURATA-1YN	CYW43439	Type 1YN is a small and high-performance module based on Infineon CYW43439 combo chipset which supports Wi-Fi® 802.11b/g/n + Bluetooth® 5.2 BR/EDR/LE up to 65Mbps PHY data rate on Wi-fi® and 3Mbps PHY data rate on Bluetooth®. The WLAN section supports SDIO v2.0 interface and the Bluetooth® section supports high-speed 4-wire UART interface and PCM for audio data.

Create a new project from scratch

Module	Device	Description
MURATA-1DX	CYW4343W	Type 1DX is a small and high-performance module based on Infineon CYW4343W combo chipset which supports Wi-Fi® 802.11b/g/n + Bluetooth® 5.1 BR/EDR/LE up to 65Mbps PHY data rate on Wi-fi® and 3Mbps PHY data rate on Bluetooth®. The WLAN section supports SDIO v2.0 interface and the Bluetooth® section supports high-speed 4-wire UART interface and PCM for audio data.
CYW9P62S2-M2BASE-4373	CYW4373	Infineon's AIROC™ CYW4373/CYW4373E/CYW43732 single-chip combo device features 1x1 dual-band 2.4 GHz and 5 GHz Wi-Fi 5 (802.11ac) and Bluetooth® 5.2.
STERLING-LWB5plus	CYW4373	NVRAM file for Sterling LWB5+ development board.
USER-MODULE	ALL	Custom USER-MODULE configuration, in this case User should provide own NVRAM header somewhere in project (e.g. in Core/Inc folder).

7.3 Enable Software pack

1. Select the **Pinout & Configuration** tab.
2. Expand **Software Packs** and select **Infineon.Connectivity-STM32.<version>**.
3. Click the checkbox next to **Wireless Connectivity**.

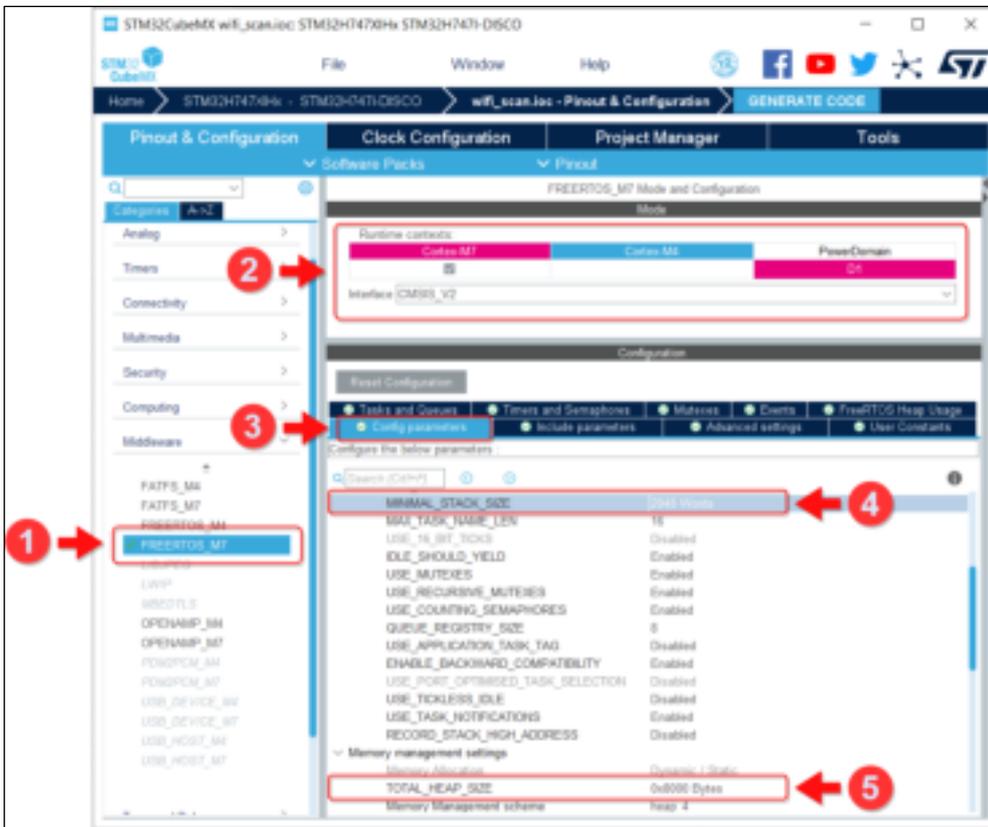


STM32 connectivity expansion pack user guide

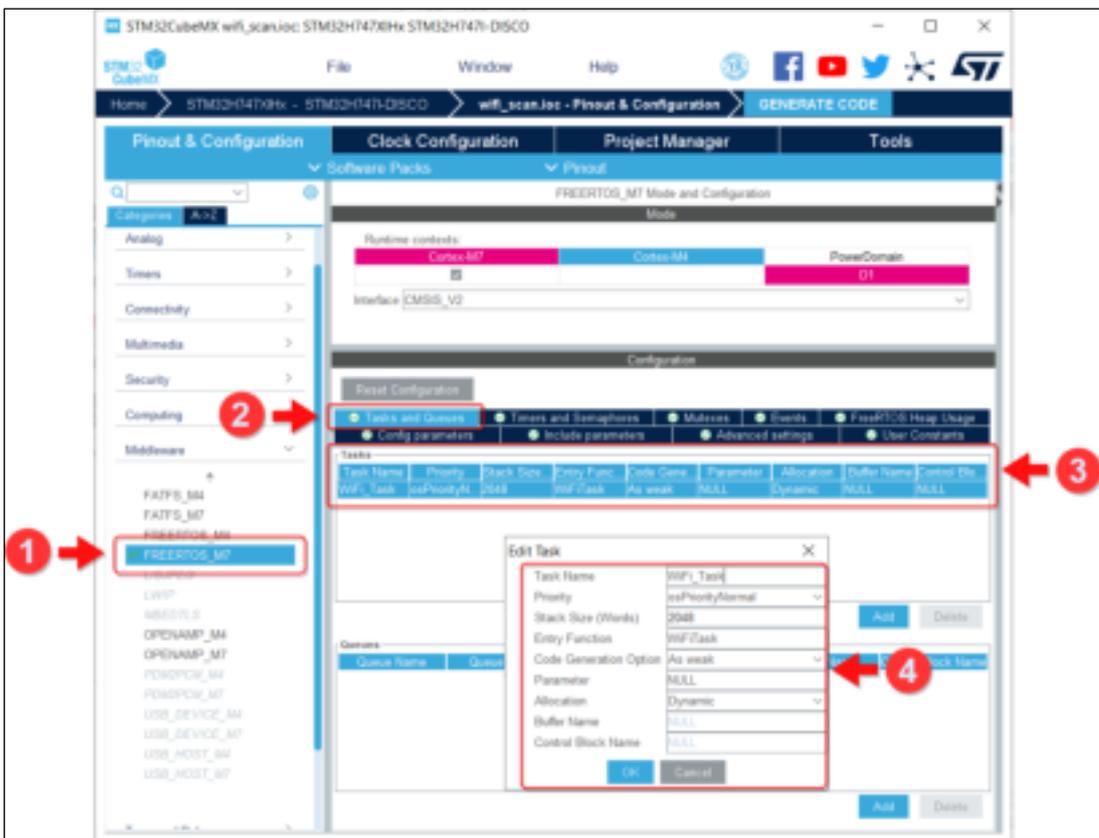
Create a new project from scratch

7.4 FreeRTOS configuration

Select FreeRTOS version and configure Stack Size and Heap size as required for the application.



Under **Tasks and Queues**, configure Default task and its stack size.



Create a new project from scratch

7.5 MbedTLS configuration

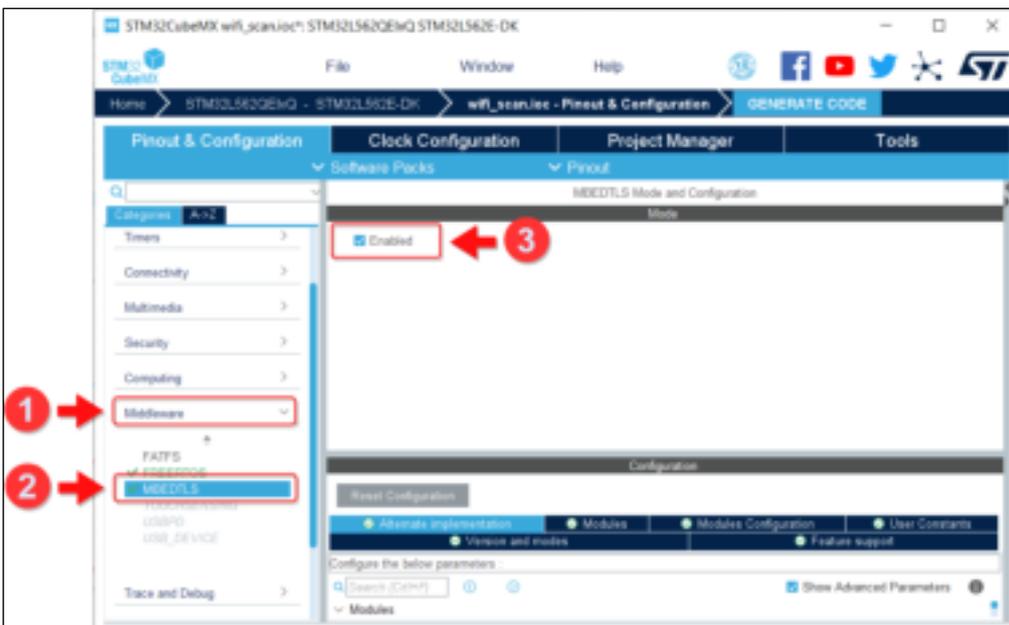
The mbedTLS is required by LwIP (Lightweight IP) WCM (Wi-Fi Connection Manager) Pack's components. To enable mbedTLS. The STM32L5 MCU is used as an example to demonstrate Crypto features (AES, HASH, etc.) HW acceleration configuration:

Open the project's *.IOC file w/ STM32CubeMx.

Navigate to Infineon Pack's components and switch WCM to WCM/WPS/mbedTLS.



Navigate to **Select Components**, select **Middleware** and then select **MBEDTLS** for target device and select the **Enabled** check box.



Create a new project from scratch

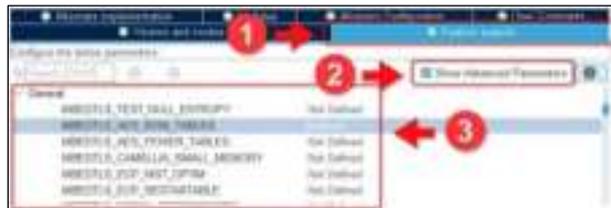
Ensure that the following features and modes are enabled by performing appropriate steps:

- mbedTLS sources are added to application
- mbedTLS config is applied to support Infineon's connectivity middleware

```

MBEDTLS_ENTROPY_HARDWARE_ALT
MBEDTLS_AES_ROM_TABLES
MBEDTLS_CIPHER_MODE_CBC
MBEDTLS_NO_PLATFORM_ENTROPY
MBEDTLS_ENTROPY_FORCE_SHA256
MBEDTLS_AES_C
MBEDTLS_SHA256_C
    
```

Note: Set "Not defined" for unneeded modes to reduce memory consumption and eliminate unused code.



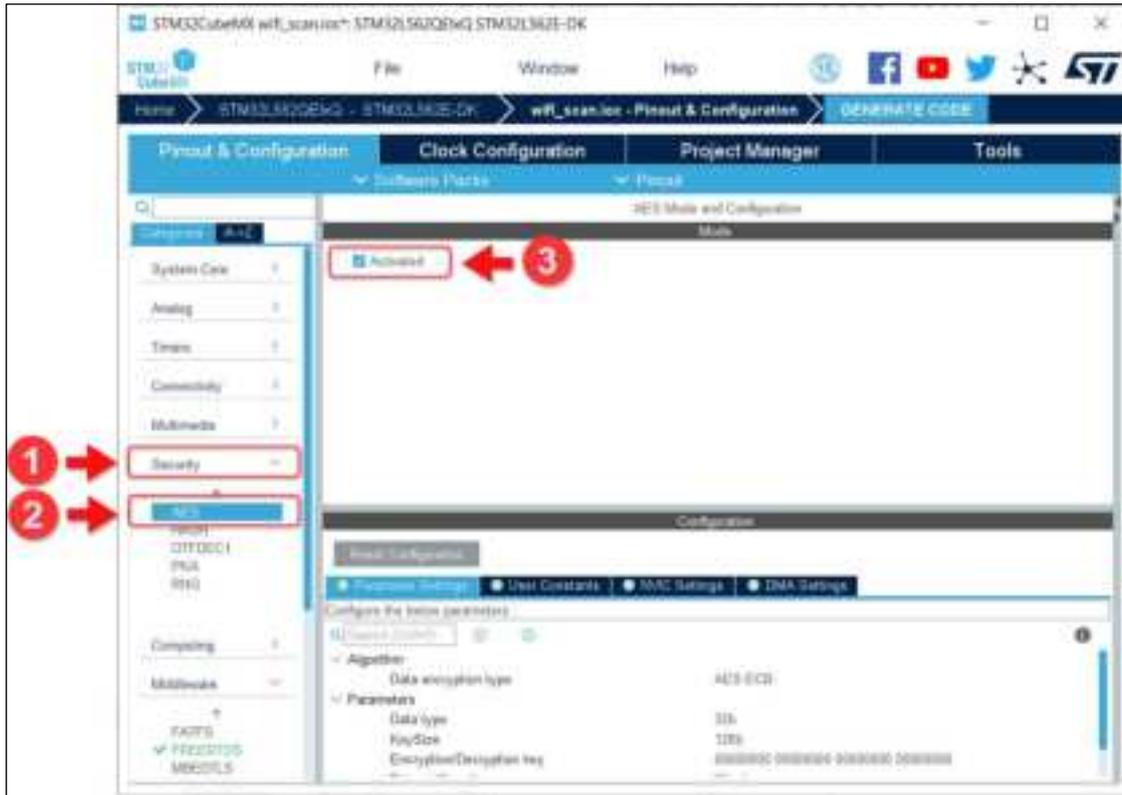
7.5.1 Crypto HW acceleration

STM32 offers HW acceleration for the following crypto-related functions:

	STM32H7	STM32L5	Notes
RNG	+	+	
AES		+	AES-128/256 (ECB, CBC, CTR, GCM GMAC, CCM)
HASH		+	SHA1, SHA224, SHA256, MD5 HMAC SHA1, HMAC SHA224, HMAC SHA256, HMAC MD5
PKA		+	Public Key Cryptography
OTFDEC1		+	On-the-fly decryption of Octo-SPI external memories (AES-128)

Create a new project from scratch

The IP modules listed above must be enabled (Activated) from the "Security" section of STM32CubeMX configurator.



To enable HW acceleration the following literals have to be defined for mbedTLS (should be done in STM32CUBE MX configurator):

```
MBEDTLS_AES_ALT
MBEDTLS_CCM_ALT
MBEDTLS_GCM_ALT
MBEDTLS_MD5_ALT
MBEDTLS_SHA1_ALT
MBEDTLS_SHA256_ALT
MBEDTLS_ENTROPY_HARDWARE_ALT
```


Create a new project from scratch

Set MBEDTLS_ENTROPY_HARDWARE_ALT to "Defined" in the STM32CubeMX configurator:



The tool will add hardware_rng.c source file to the user's project.

This will provide the mbedtls_hardware_poll() implementation, which relies on the devices' HW RNG IP block.

A call to the standard STM32 HAL RNG API (HAL_RNG_GenerateRandomNumber()) will be used by the system to fulfill the mbedtls entropy pool.

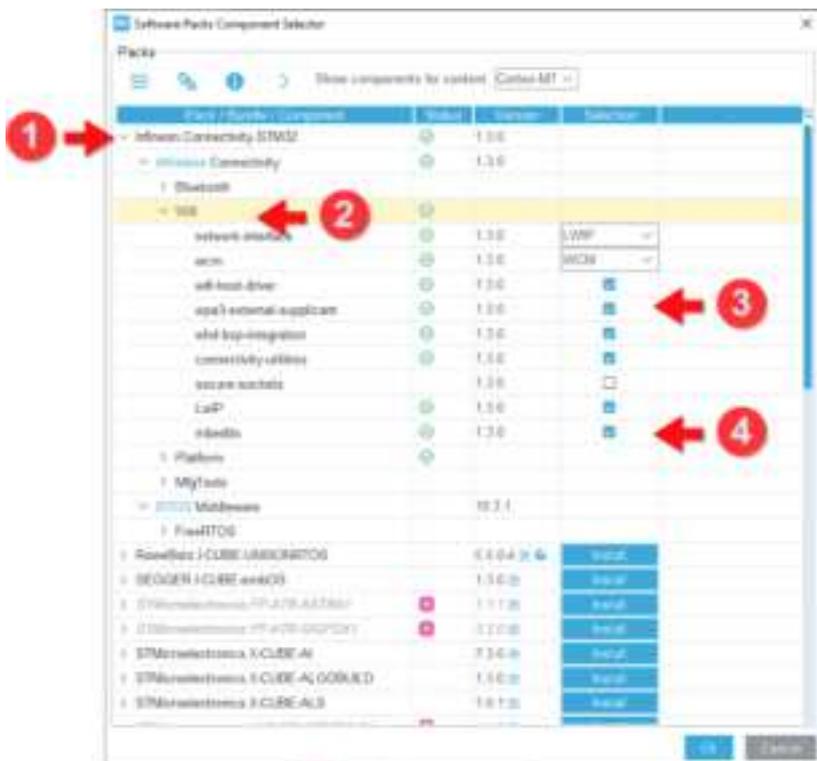
Create a new project from scratch

7.6 Wpa3-external-suplicant

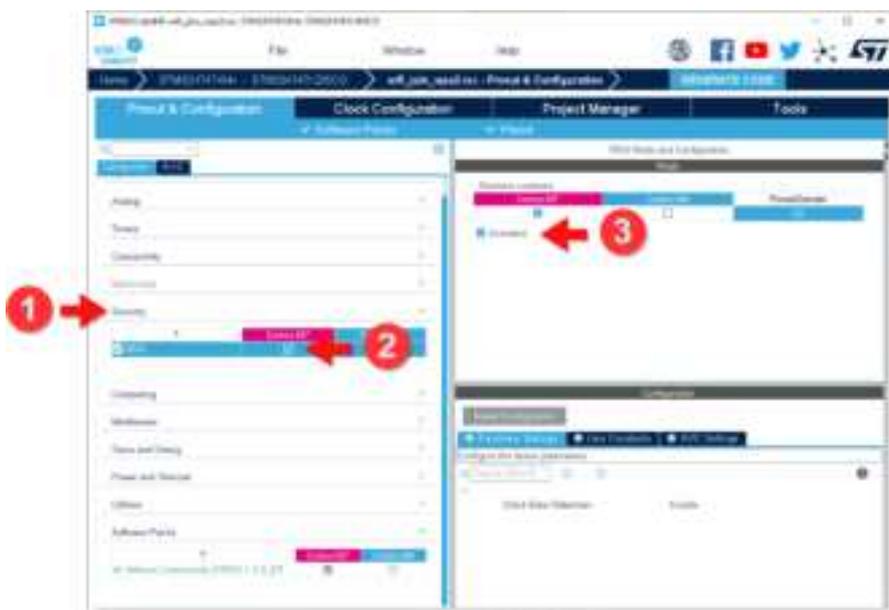
Library wpa3-external-suplicant supports WPA3 SAE authentication using HnP (Hunting and Pecking Method) using RFC <https://datatracker.ietf.org/doc/html/rfc7664> and H2E (Hash to Element Method) using RFC <https://datatracker.ietf.org/doc/html/draft-irtf-cfrg-hash-to-curve-10> and following 802.11 spec 2016.

This library required mbedTLS version 2.25.0. To enable wpa3-external-suplicant supports:

Navigate to Infineon Pack's components, then **Wifi** and enable **wpa3-external-suplicant** and **mbedtls**.



Navigate to **Select Components**, select **Security** and then select **RNG** for target device and select the **Enabled** check box, and enable **Activated** check box

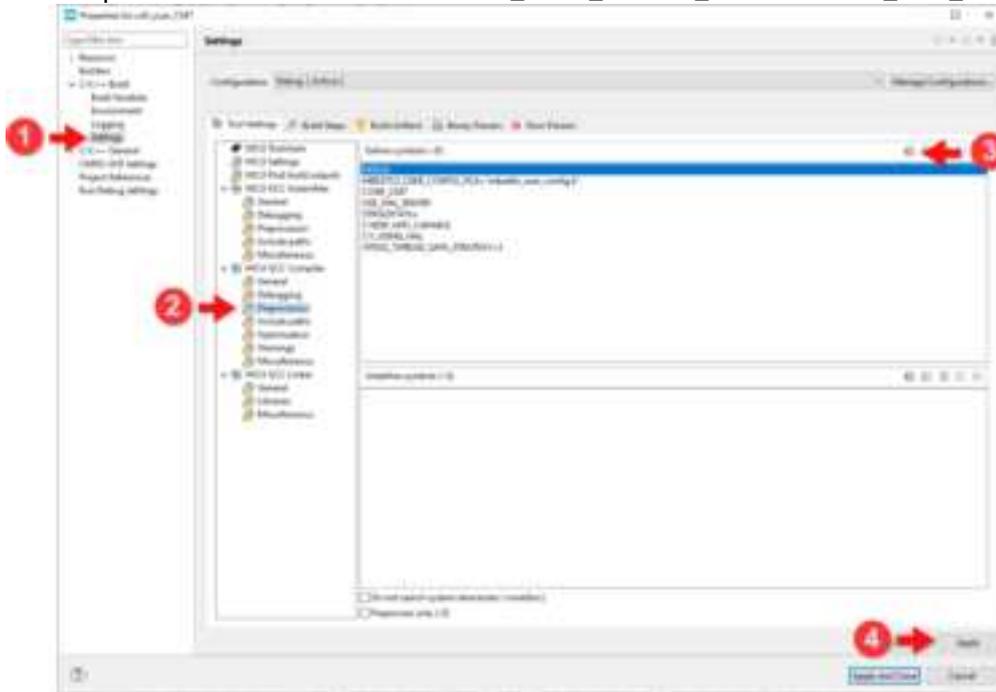


Create a new project from scratch

After generating your code copy **mbedtls_user_config.h** folder from Infineon pack to your project directory (e.g. CORE/Inc folder):

C:\Users*<USER>*\STM32Cube\Repository\Packs\Infineon\Connectivity-STM32\1.3.0\Middlewares\Third_Party\configs\mbedtls_user_config.h

Add Preprocessor macro name: `MBEDTLS_USER_CONFIG_FILE="mbedtls_user_config.h"`



Add implementation for Mbedtls entropy, as shown in the following example for STM32H7 RNG:

```
#include "mbedtls_user_config.h"

#ifdef MBEDTLS_ENTROPY_HARDWARE_ALT

#include "main.h"
#include "string.h"
#include "stm32h7xx_hal.h"
#include "mbedtls/entropy_poll.h"

extern RNG_HandleTypeDef hrng;

int mbedtls_hardware_poll( void *Data, unsigned char *Output, size_t Len, size_t *oLen )
{
    uint32_t index;
    uint32_t randomValue;

    for (index = 0; index < Len/4; index++)
    {
        if (HAL_RNG_GenerateRandomNumber(&hrng, &randomValue) == HAL_OK)
        {
            *oLen += 4;
            memset(&(Output[index * 4]), (int)randomValue, 4);
        }
        else
        {
            Error_Handler();
        }
    }

    return 0;
}

#endif /*MBEDTLS_ENTROPY_HARDWARE_ALT*/
```

Create a new project from scratch

If the MCU supports the HW Crypto capability, we recommend to use this feature. Otherwise, set the compiler optimization option as the speed or size to make Mbedtls work faster.

Refer to the code example {Path_to_pack}\Projects\{board}\Applications\wifi_join_wpa3, for usage demonstration.

7.7 Configure resources for Wi-Fi connectivity

The following Peripherals and I/O lines are required for the host MCU to communicate to Infineon connectivity device(s) for Wi-Fi:

7.7.1 SDIO

SDIO is used as an interface with Infineon Connectivity devices.

The SDMMC HAL component is required for STM32 host MCU to access/control Infineon connectivity device(s).

1. Add the API call at initialization with appropriate handle passed in:

```
SD_HandleTypeDef SDHandle = { .Instance = SDMMC1 };
cy_rslt_t result = stm32_cypal_wifi_sdio_init(&SDHandle);
```

2. SDMMC Interrupt handler must be overwriting in application and call stm32_cyhal_sdio_irq_handler function:

```
void SDMMC1_IRQHandler(void)
{
    stm32_cyhal_sdio_irq_handler();
}
```

Make sure the SDMMC instance selected has its pins routed to the Infineon Connectivity device. Follow the steps listed to enable/configure SDIO in STM32CubeMX:

Enable SDMMC block in **STM32CubeMX > Pinout & Configuration > Connectivity**.



Create a new project from scratch

Disable generation function call of SDMMC initialization (MX_SDMMC_SD_Init).



7.7.2 Control pins

Infineon Connectivity devices require control lines to be connected to host MCU:

Line Name	FW Name	Description
WL_REG_ON	WIFI_WL_REG_ON	This is a power pin that shuts down the device WLAN section.
WL_HOST_WAKE	CYBSP_WIFI_HOST_WAKE	WLAN Host Wake: Active Low (OOB IRQ)
WL_DEV_WAKE		WLAN Device Wake <i>Note: WL_DEV_WAKE is not used in current version of PAL.</i>

7.7.2.1 WL_REG_ON

A power pin that shuts down the device WLAN section. WL_REG_ON must be configured as output with following parameters:

GPIO Parameter	Value	Note
Direction	GPIO_Output	
Pin Context Assignment	ARM Cortex-M7	Assign to core, where Connectivity run.
GPIO output level	Low	
GPIO mode	Output Push Pull (PP)	
GPIO Pull-up/Pull-down	No pull-up and no pull-down	
Maximum output speed	Low	
User label	WIFI_WL_REG_ON	

Create a new project from scratch



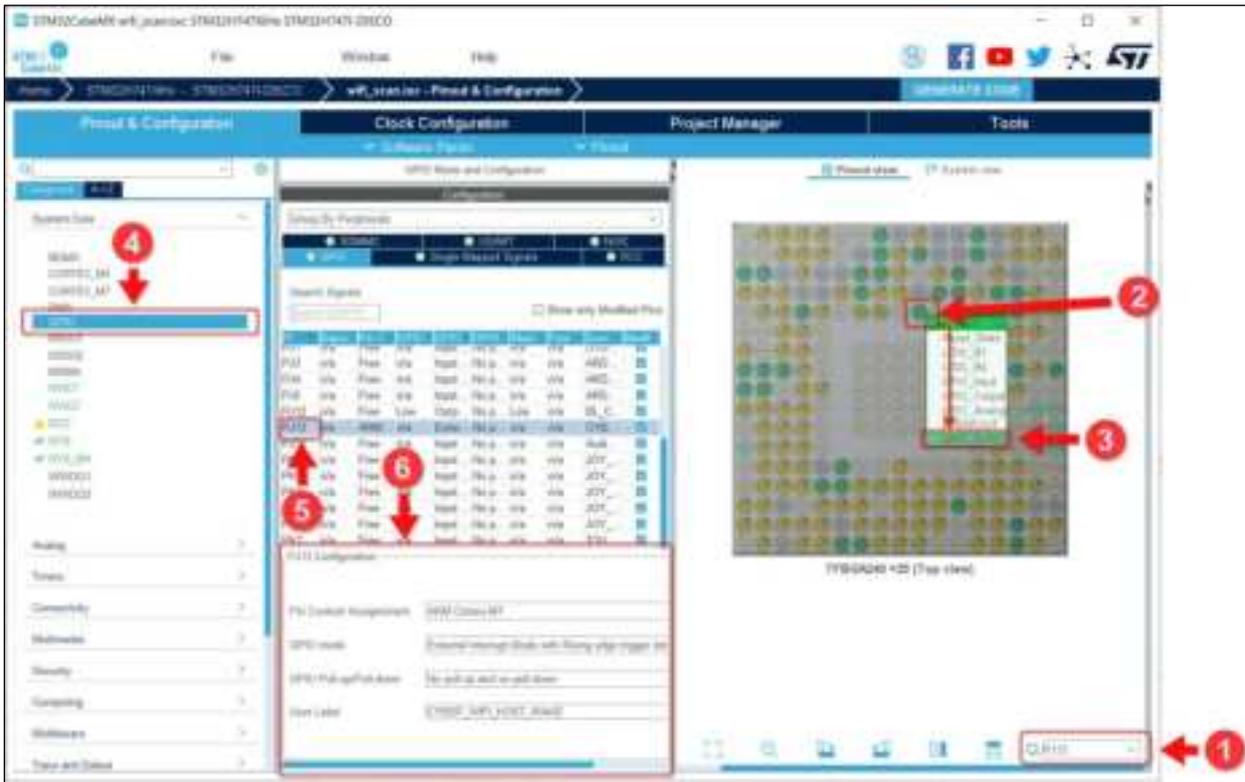
7.7.2.2 WL_HOST_WAKE

Host MCU Wake signal from WLAN section. WL_HOST_WAKE must be configured in External Interrupt mode / EXTI with following parameters:

GPIO Parameter	Value	Note
Direction	GPIO_EXTIxx	
Pin Context Assignment	ARM Cortex-M7	Assign to core, where Connectivity runs.
GPIO mode	External Interrupt mode with Rising edge trigger detection	
GPIO Pull-up/Pull-down	No pull-up and no pull-down	
User label	CYBSP_WIFI_HOST_WAKE	
NVIC for EXTI	Enable	

Create a new project from scratch

1. Configure in STM32CubeMX:



2. Enable NVIC interrupt for EXTI line:



3. EXTI Callback handler must be overwriting in application and call stm32_cyhal_gpio_irq_handler function:

```
void HAL_GPIO_EXTI_Callback(uint16_t GPIO_Pin)
{
    stm32_cyhal_gpio_irq_handler(GPIO_Pin);
}
```

Create a new project from scratch

7.8 Configure resources for Bluetooth® connectivity

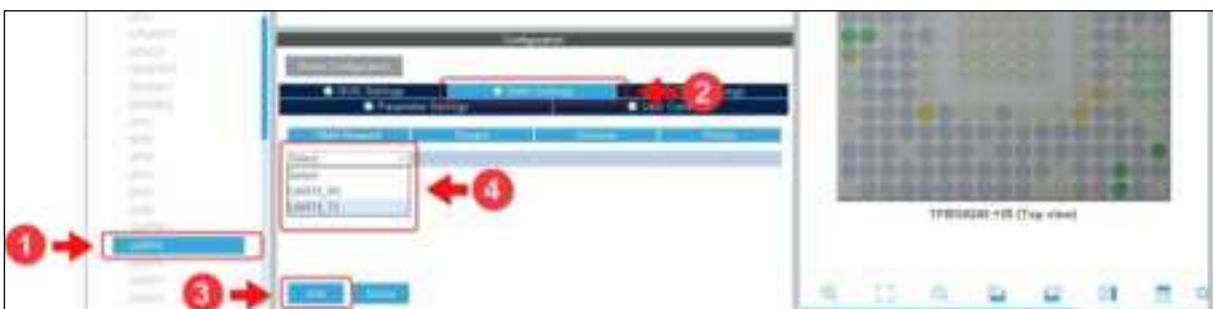
The following Peripherals and I/O lines required for the host MCU to communicate to Infineon connectivity device(s) for Bluetooth:

7.8.1 UART

1. Enable UART block in **STM32CubeMX > Pinout & Configuration > Connectivity**.
2. Configure Mode as **Asynchronous**.
3. Configure Hardware Flow Control (RS232) as **CTS/RTS**.
4. Enable UART interrupt in **NVIC Settings**.



5. Add DMA for RX and TX in **DMA Settings**. Use default settings for RX/TX.



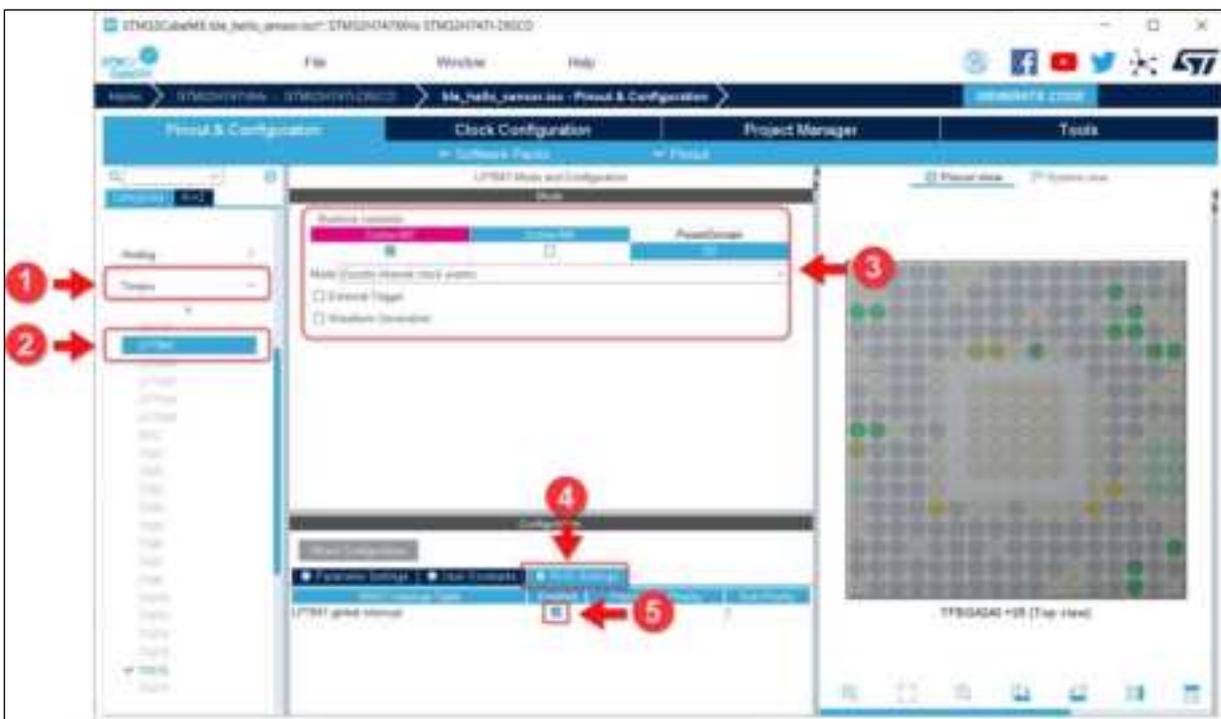
Create a new project from scratch

6. Enable UART Callback.



7.8.2 LPTIMER

1. Enable LPTIMER block in **STM32CubeMX > Pinout & Configuration > Timers**.
2. Configure Mode as **Counts internal clock events**.
3. Enable LPTIMER interrupt in **NVIC Settings**.



Create a new project from scratch

4. Enable LPTIM Callback.



7.8.3 Control pins

Infineon Connectivity devices require control lines to be connected to host MCU:

Line Name	FW Name	Description
BT_REG_ON	CYBSP_BT_POWER	Used by the PMU to power-up or power-down the internal regulators used by the Bluetooth® section.
BT_HOST_WAKE	CYBSP_BT_HOST_WAKE	Bluetooth® device wake-up: Signal from the host to the CYW43xx indicating that the host requires attention. <ul style="list-style-type: none"> Asserted: The Bluetooth® device must wake-up or remain awake. De-asserted: The Bluetooth® device may sleep when sleep criteria are met. The polarity of this signal is software configurable and can be asserted HIGH or LOW. <i>Note: BT_HOST_WAKE is not used in current version of PAL.</i>
BT_DEV_WAKE	CYBSP_BT_DEVICE_WAKE	Host wake-up. Signal from the CYW43xx to the host indicating that the CYW43xx requires attention. <ul style="list-style-type: none"> Asserted: host device must wake-up or remain awake. De-asserted: host device may sleep when sleep criteria are met. The polarity of this signal is software configurable and can be asserted HIGH or LOW <i>Note: BT_DEV_WAKE is not used in current version of PAL.</i>

Create a new project from scratch

7.8.3.1 BT_REG_ON

A power pin that shuts down the device Bluetooth® section. BT_REG_ON must be configured as output with the following parameters:

GPIO Parameter	Value	Note
Direction	GPIO_Output	
Pin Context Assignment	ARM Cortex-M7	Assign to core, where Connectivity run.
GPIO output level	Low	
GPIO mode	Output Push Pull (PP)	
GPIO Pull-up/Pull-down	No pull-up and no pull-down	
Maximum output speed	Low	
User label	CYBSP_BT_POWER	

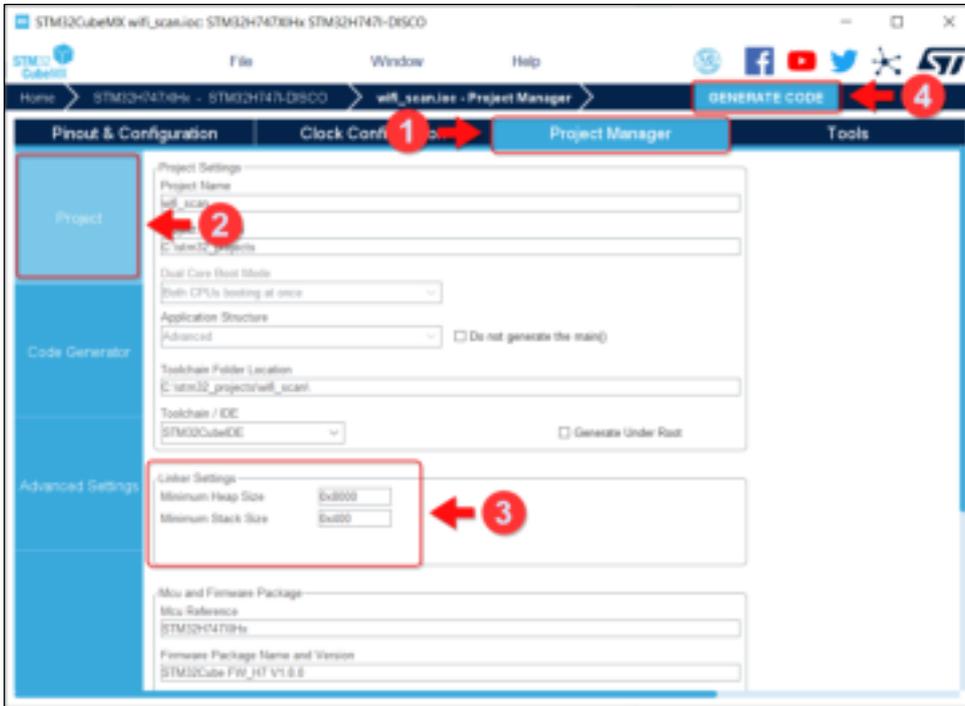
Configuration in STM32CubeMX:



Create a new project from scratch

7.9 Heap and stack configuration

Configure Heap and Stack size required for the example app.



7.10 Generating code

1. After clicking **Generate Code**, copy the following files from existing examples provided along with the pack:

- cybsp.h
- lwipopts.h

Location of these files in the pack:

```
STM32Cube\Repository\Packs\Infineon\Connectivity-STM32\1.3.0\Projects\STM32H747I-
DISCO\Applications\wifi_scan\Core\Inc
```

2. Add the following to the *FreeRTOSConfig.h* file:

```
/* Enable using CY_HAL for rtos-abstraction */
#define CY_USING_HAL
```

3. Update the following fields in the *cybsp.h* file to match the configurations done in the [Configuring Control pins](#) section

```
/** These names are explicitly referenced in the support libraries */
#define CYBSP_WIFI_WL_REG_ON          ***
#define CYBSP_WIFI_HOST_WAKE        ***
```

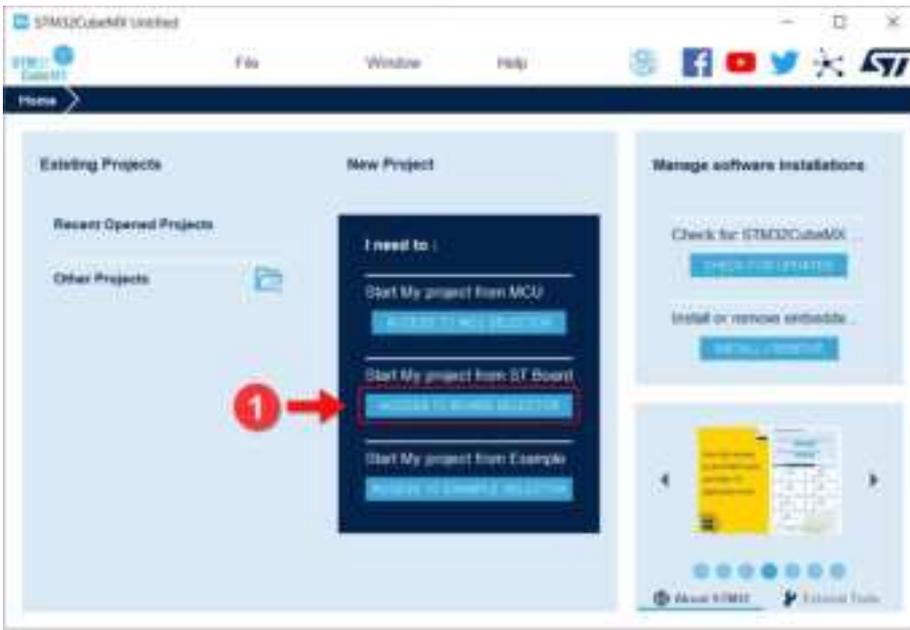
Create a new project for non-H7 MCU boards

8 Create a new project for non-H7 MCU boards

This section explains how to create new example project for any non-H7 MCU boards using the expansion pack.

8.1 Creating a project

1. Start creating a project via the Access to Board Selector option.



2. Select a board like STM32L4R9I-DISCO
 - Enter/select the board number (STM32L4R9I-DISCO) and click on your selected board
 - Select Start Project.



Create a new project for non-H7 MCU boards

3. Select Software Components from STM32 Connectivity Expansion Pack
 - Select the Pinout & Configuration tab.
 - Select **Software Packs > Select Components**. This will show a list of the installed packs and their contents.
 - Platform/device is selected as CYW43438 for reference along with other components required for the Wi-Fi Example.
 - Enable Software components as required for the Wi-Fi Example.
 - Refer to [Enable Software components from STM32 Connectivity Expansion Pack](#).

8.2 FreeRTOS configuration

Follow same steps as mentioned in [FreeRTOS Configuration](#).

8.3 Other configurations

1. Configure SDMMC (refer to [SDIO](#)).
2. Configure Control Pins (refer to [Control Pins](#)).
3. Configure Heap and Stack size (refer to [Heap and Stack Configuration](#)).

8.4 Changes required in PAL library

By default, Expansion pack supports only H7 MCU variant. The following changes are required to support other MCU variants.

1. stm32_cyhal_common.h
(Middlewares\Third_Party\Infineon_Wireless\Infineon\pal\targets\TARGET_STM32\Inc) folder


```
#elif defined (STM32L4R9xx)
    #define TARGET_STM32L4xx
#elif defined (TARGET_STM32L4xx)
    #include "stm32l4xx.h"
    #include "stm32l4xx_hal.h"
    #include "stm32l4xx_hal_def.h"
```
2. stm32_cyhal_sdio_ex.h
 - Define STM32_RCC_PERIPHCLK_SDMMC based in the SDMMC* type supported by MCU variant.
 - For L4, it is RCC_PERIPHCLK_SDMMC1:


```
#elif defined (TARGET_STM32L4xx)
    /* RCC clock for SDMMC */
    #define STM32_RCC_PERIPHCLK_SDMMC RCC_PERIPHCLK_SDMMC1
```
3. stm32_cyhal_gpio.c
Define "exti_table" based on the IRQn_Type defined in the stm32l4r9xx.h.

8.5 Changes required in main.c

To enable SDMMC to work with Wi-Fi connectivity device:

1. The API call has to be added at initialization with appropriate handle passed in:

```
SD_HandleTypeDef SDHandle = { .Instance = SDMMC1 };
cy_rslt_t result = stm32_cypal_wifi_sdio_init(&SDHandle);
```

Create a new project for non-H7 MCU boards

- SDMMC Interrupt handler must be overwriting in application and call `stm32_cyhal_sdio_irq_handler` function:

```
void SDMMC1_IRQHandler (void)
{
    stm32_cyhal_sdio_irq_handler();
}
```

- GPIO Interrupt handler must be overwriting in application and call `stm32_cyhal_gpio_irq_handler` function

```
void HAL_GPIO_EXTI_Callback (uint16_t GPIO_Pin)
{
    stm32_cyhal_gpio_irq_handler (GPIO_Pin);
}
```

8.6 DMA configuration

PAL Library is currently supporting SDIO CMD53 transfer using Internal DMA Registers in SDMMC. If the MCU variant does not support IDMABASE, Use DMA Channels and Modify below functions to handle SDIO Command 53.

- `cyhal_sdio_bulk_transfer`
- `stm32_cyhal_sdio_irq_handler`

8.7 OctoSPI configuration

STM32L4R9I-DISCO has external flash memory available and can be used for placing the Wi-Fi Firmware.

- Linker script (*.ld) change to address external memory:

```
OSPI (rx) : ORIGIN = 0x90000000, LENGTH = 131072K
```

- Add Linker script with section name defining where WiFi Firmware needs to be placed:

```
.whd_fw :
{
    __whd_fw_start = .;
    KEEP(*(.whd_fw))
    __whd_fw_end = .;
} > OSPI
```

- Add Preprocessor macro name:

```
CY_STORAGE_WIFI_DATA=".whd_fw"
```

Known issues/limitations

9 Known issues/limitations

This section lists the known issues/limitations of this release:

Problem	Component	Workaround
Sometimes, STM32 detects UART "Frame error" during the Bluetooth® LE communication (with CYW43012), which causes the Bluetooth® LE functionality to stop.	btstack-integration (CYW43012 BT FW)	Register a User UART Error Callback (by using HAL_UART_RegisterCallback function) with implementing the Bluetooth® LE or System reset.
STM32CubeIDE returns the linkage error "undefined reference to _nx_nd_cache***" when IPv6 is enabled in the NetxDuo configuration.	STM32CubeMx/STM32CubeIDE	Manually add nx_nd_cache_***.c files from the MCU pack (e.g STM32Cube_FW_U5_V1.1.1\Middlewares\ST\netxduo\common\src) to the project workspace.
STM32CubeMx does not remove sources/includes of the PDSC component from the project workspace (STM32CubeIDE/EWARM), when another variant of this component is disabled or changed. It causes a build error when two versions of one component are added to the project (e.g. device CYW43012 and CYW4373)	STM32CubeMx/STM32CubeIDE	Option 1: Manually remove files/includes of the previous component variant from the project workspace. Option 2: Remove the project workspace folder and generate a project from STM32CubeMx again. Be careful with the custom linker script – it may be missing after removing the project folder.
STM32CubeIDE does not include source files of modified device component for wifi_bt_tester project (i.e. if CYW4343W is selected instead of CYW43012 in device dropdown during Code Generate in STM32CubeMX)	STM32CubeMx/STM32CubeIDE	This can be fixed by modifying the project to "C" instead of C++ in STM32CubeIDE before Generating the project.
Bluetooth® LE examples with the CYW4373 STERLING-LWB5 plus module will fail to connect if the Bluetooth® LE host is using the LE 2M PHY.	btstack-integration (CYW4373 STERLING-LWB5plus)	None. This will be addressed in a future release.

Revision history

Revision history

Date	Version	Description
2021-03-25	**	Initial release.
2022-11-14	*A	Updated from version 1.1.0 to version 1.2.0.
2022-12-22	*B	Updated from version 1.2.0 to version 1.3.0.
2023-03-29	*C	Updated from version 1.3.0 to version 1.4.0.

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